

Low-Power LCD Microcontroller

General Description

The MAXQ2000 microcontroller is a low-power, 16-bit device that incorporates a liquid-crystal display (LCD) interface that can drive up to 100 (-RBX/-RBX+) or 132 (-RAX/-RAX+/-RFX/-RFX+) segments. The MAXQ2000 is uniquely suited for the blood-glucose monitoring market, but can be used in any application that requires high performance and low-power operation. The device can operate at a maximum of either 14MHz ($V_{DD} > 1.8V$) or 20MHz ($V_{DD} > 2.25V$). The MAXQ2000 has 32kWords of flash memory, 1kWord of RAM, three 16-bit timers, and one or two universal synchronous/asynchronous receiver/transmitters (UARTs). Flash memory aids prototyping and low-volume production. The microcontroller core is powered by a 1.8V supply, with a separate I/O supply for optimum flexibility. An ultra-low-power sleep mode makes these parts ideal for battery-powered, portable equipment.

Applications

Medical Instrumentation
 Battery-Powered and Portable Devices
 Electrochemical and Optical Sensors
 Industrial Control
 Data-Acquisition Systems and Data Loggers
 Home Appliances
 Consumer Electronics
 Thermostats/Humidity Sensors
 Security Sensors
 Gas and Chemical Sensors
 HVAC
 Smart Transmitters

Typical Operating Circuit, Pin Configurations, and Ordering Information appear at end of data sheet.

MAXQ is a registered trademark of Maxim Integrated Products, Inc.

SPI is a trademark of Motorola, Inc.

1-Wire is a registered trademark of Dallas Semiconductor Corp., a wholly owned subsidiary of Maxim Integrated Products, Inc.

Note: Some revisions of this device may incorporate deviations from published specifications known as errata. Multiple revisions of any device may be simultaneously available through various sales channels. For information about device errata, go to: www.maxim-ic.com/errata.

Features

- ◆ **High-Performance, Low-Power, 16-Bit RISC Core**
 DC to 20MHz Operation, Approaching 1MIPS per MHz
 Dual 1.8V Core/3V I/O Enables Low Power/Flexible Interfacing
 33 Instructions, Most Single Cycle
 Three Independent Data Pointers Accelerate Data Movement with Automatic Increment/Decrement
 16-Level Hardware Stack
 16-Bit Instruction Word, 16-Bit Data Bus
 16 x 16-Bit, General-Purpose Working Registers
 Optimized for C-Compiler (High-Speed/Density Code)
- ◆ **Program and Data Memory**
 32kWords Flash Memory, Mask ROM for High-Volume Applications
 10,000 Flash Write/Erase Cycles
 1kWord of Internal Data RAM
 JTAG/Serial Boot Loader for Programming
- ◆ **Peripheral Features**
 Up to 50 General-Purpose I/O Pins
 100/132 Segment LCD Driver
 Up to 4 COM and 36 Segments
 Static, 1/2, and 1/3 LCD Bias Supported
 No External Resistors Required
 SPI™ and 1-Wire® (-RAX/-RAX+/-RFX/-RFX+ Only)
 Hardware I/O Ports
 One or Two Serial UARTs
 One-Cycle, 16 x 16 Hardware Multiply/Accumulate with 48-Bit Accumulator
 Three 16-Bit Programmable Timers/Counters
 8-Bit, Subsecond, System Timer/Alarm
 32-Bit, Binary Real-Time Clock with Time-of-Day Alarm
 Programmable Watchdog Timer
- ◆ **Flexible Programming Interface**
 Bootloader Simplifies Programming
 In-System Programming Through JTAG
 Supports In-Application Programming of Flash Memory
- ◆ **Ultra-Low-Power Consumption**
 190µA typ at 8MHz Flash Operation, PMM1 at 2.2V
 700nA typ in Lowest Power Stop Mode
 Low-Power 32kHz Mode and Divide-by-256 Mode

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ABSOLUTE MAXIMUM RATINGS

Voltage Range on Any Pin Relative to Ground Except V_{DD} -0.5V to (V_{DDIO} + 0.5)V
 Voltage Range on V_{DD} Relative to Ground -0.5V to +2.75V
 Voltage Range on V_{DDIO} Relative to Ground -0.5V to +3.6V

Operating Temperature Range -40°C to +85°C
 Storage Temperature Range -65°C to +150°C
 Soldering Temperature Refer to the IPC/JEDEC J-STD-020 Specification.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{DD} = V_{DD(MIN)} to V_{DD(MAX)}, V_{DDIO} = 2.7V to 3.6V, T_A = -40°C to +85°C.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|------------------------|---|-----------------|------|------|-------|
| Core Supply Voltage | V _{DD} | 32k x 16 flash | 1.8 | 2.5 | 2.75 | V |
| | | Flash programming | 2.25 | 2.5 | 2.75 | |
| I/O Supply Voltage | V _{DDIO} | | V _{DD} | | 3.6 | V |
| V _{DD} Slew Rate | | V _{DD} rising (Note 2) | 225 | | | mV/ms |
| Active Current, f _{HFIN} = 14MHz (Note 3) | I _{DD1} | /1 mode | | 6.0 | 9.2 | mA |
| | I _{DD2} | /2 mode | | 5.6 | 8.6 | |
| | I _{DD3} | /4 mode | | 3.4 | 5.1 | |
| | I _{DD4} | /8 mode | | 1.9 | 2.9 | |
| | I _{DD5} | PMM1 mode | | 0.5 | 0.7 | |
| | I _{DD6} | PMM2 mode; 32KIN = 32.768kHz | Rev A2 | | 4.8 | |
| Rev A3 | | | | 0.1 | 0.95 | |
| Active Current, f _{HFIN} = 20MHz (Note 3) | I _{DD1} | /1 mode | | 6.5 | 10.4 | mA |
| | I _{DD2} | /2 mode | | 5.9 | 9.6 | |
| | I _{DD3} | /4 mode | | 3.8 | 6.2 | |
| | I _{DD4} | /8 mode | | 2.2 | 3.8 | |
| | I _{DD5} | PMM1 mode | | 0.6 | 1.4 | |
| | I _{DD6} | PMM2 mode; 32KIN = 32.768kHz | Rev A2 | | 4.8 | |
| Rev A3 | | | | 0.1 | 0.95 | |
| Active Current | | Execution from flash memory, 20MHz, V _{DD} = 2.2V, T _A = +25°C | | 5.1 | | mA |
| | | Execution from flash memory, 8MHz, /8 mode, V _{DD} = 2.2V, T _A = +25°C | | 0.85 | | |
| | | Execution from flash memory, 8MHz, PMM1 mode, V _{DD} = 2.2V, T _A = +25°C | | 0.19 | | |
| | | Execution from RAM, 8MHz, /8 mode, V _{DD} = 2.2V, T _A = +25°C | | 0.30 | | |
| | | Execution from RAM, 1MHz, /1 mode, V _{DD} = 2.2V, T _A = +25°C | | 0.14 | | |
| Stop-Mode Current | I _{STOP(VDD)} | -40°C < T _A < +25°C | | 0.7 | 55 | μA |
| | | T _A = +85°C | | 20 | 550 | |
| Digital I/O Supply Current | I _{DDIO} | RTC enabled; HFIN ≥ 14MHz; all I/O disconnected | | 1 | 50 | μA |

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ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = V_{DD(MIN)}$ to $V_{DD(MAX)}$, $V_{DDIO} = 2.7V$ to $3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|-------------|--|-------------------------------------|-----|-----------------------|-----------|
| Input High Voltage: HFIN and 32KIN | V_{IH1} | | $0.8 \times V_{DDIO}$ | | V_{DDIO} | V |
| Input High Voltage: P6.4–P6.5 and P7.0–P7.1 | V_{IH2} | SVS on, $V_{LCD} = 3.3V$ | $0.8 \times V_{LCD}$ | | V_{LCD} | V |
| Input High Voltage: All Other Pins | V_{IH3} | | $0.8 \times V_{DDIO}$ | | V_{DDIO} | V |
| Input Low Voltage: HFIN and 32KIN | V_{IL1} | | 0 | | $0.2 \times V_{DDIO}$ | V |
| Input Low Voltage: All Other Pins | V_{IL2} | | 0 | | $0.2 \times V_{DDIO}$ | V |
| Output High Voltage: P6.4–P6.5 and P7.0–P7.1 | V_{OH1} | SVS on; $I_{OH(MAX)} = 0.75mA$; $V_{LCD} = 2.7V$ | $V_{LCD} - 0.2$ | | | V |
| Output High Voltage: All Other Pins | V_{OH2} | $I_{OH(MAX)} = 0.75mA$; $V_{DDIO} = 1.8V$ | $V_{DDIO} - 0.2$ | | | V |
| Output Low Voltage for All Other Pins | V_{OL1} | $I_{OL} = 1.0mA$; $V_{DDIO} = 1.8V$ | GND | | 0.2 | V |
| Output Low Voltage for P6.4–P6.5 and P7.0–P7.1 | V_{OL2} | $I_{OL} = 1.4mA$; $V_{DDIO} = 2.7V$ | GND | | 0.2 | V |
| Input Leakage Current | I_L | Internal pullup disabled | -100 | | +100 | nA |
| Input Pullup Current | I_{IP} | Internal pullup enabled | -20 | | -5 | μA |
| LCD INTERFACE | | | | | | |
| LCD Reference Voltage | V_{LCD} | | 2.7 | 3.3 | 3.6 | V |
| LCD Bias Voltage 1 | V_{LCD1} | 1/3 bias | $V_{ADJ} + 2/3 (V_{LCD} - V_{ADJ})$ | | | V |
| LCD Bias Voltage 2 | V_{LCD2} | 1/3 bias | $V_{ADJ} + 1/3 (V_{LCD} - V_{ADJ})$ | | | V |
| LCD Adjustment Voltage | V_{ADJ} | Guaranteed by design | 0 | | $0.4 \times V_{LCD}$ | V |
| LCD Bias Resistor | R_{LCD} | | | 100 | | $k\Omega$ |
| LCD Adjustment Resistor | R_{LADJ} | LRA4:LRA0 = 11111b | | 200 | | $k\Omega$ |
| LCD Segment Voltage | V_{SEGxx} | When segment is driven at V_{LCD} level; $V_{LCD} = 3V$; $I_{SEGxx} = -3\mu A$; guaranteed by design | $V_{LCD} - 0.02$ | | V_{LCD} | V |
| | | When segment is driven at V_{LCD1} level; $V_{LCD1} = 2V$; $I_{SEGxx} = -3\mu A$; guaranteed by design | $V_{LCD1} - 0.02$ | | V_{LCD1} | |
| | | When segment is driven at V_{LCD2} level; $V_{LCD2} = 1V$; $I_{SEGxx} = -3\mu A$; guaranteed by design | $V_{LCD2} - 0.02$ | | V_{LCD2} | |
| | | When segment is driven at V_{ADJ} level; $V_{ADJ} = 0V$; $I_{SEGxx} = 3\mu A$; guaranteed by design | V_{ADJ} | | 0.1 | |

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ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = V_{DD(MIN)}$ to $V_{DD(MAX)}$, $V_{DDIO} = 2.7V$ to $3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|--------------------|--|-----------------------|---------------|--------------|--------|
| EXTERNAL CLOCK SOURCE | | | | | | |
| External-Clock Frequency | f_{HFIN} | External oscillator, $V_{DD} \geq 2.25V$ | 0 | | 20 | MHz |
| | | External oscillator, $V_{DD} < 2.25V$ | 0 | | 14 | |
| | | External crystal, $V_{DD} \geq 2.25V$ | 3 | | 20 | |
| | | External crystal, $V_{DD} < 2.25V$ | 3 | | 14 | |
| | | Flash programming, $V_{DD} \geq 2.25V$ | 2 | | 20 | |
| | | Flash programming, $V_{DD} < 2.25V$ | 2 | | 14 | |
| External-Clock Period | t_{CLCL} | 48% minimum duty cycle | 50 | | | ns |
| System-Clock Frequency | f_{CK} | $2.25V \leq V_{DD} \leq 2.75V$ | 0 | | 20 | MHz |
| | | $1.8V \leq V_{DD} \leq 2.75V$ | 0 | | 14 | |
| System-Clock Period | t_{CK} | | 50 | | | ns |
| REAL-TIME CLOCK | | | | | | |
| RTC Input Frequency | f_{32KIN} | 32kHz watch crystal | | 32.768 | | kHz |
| JTAG/FLASH PROGRAMMING | | | | | | |
| Flash Erase Time | | Mass erase | 200 | | | ms |
| | | Page erase | 20 | | | |
| Flash Programming Time | | | 2.5 | | 5.0 | ms |
| Write/Erase Cycles | | $T_A = +25^{\circ}C$ | 10,000 | | | cycles |
| Data Retention | | $T_A = +25^{\circ}C$ | 100 | | | years |
| SPI TIMING | | | | | | |
| SPI Master Operating Frequency | $1/t_{MCK}$ | | | | $f_{CK} / 2$ | MHz |
| SPI Slave Operating Frequency | $1/t_{SCK}$ | | | | $f_{CK} / 8$ | MHz |
| SCLK Output Pulse-Width High/Low | t_{MCH}, t_{MCL} | | $t_{MCK} / 2$ - 25 | | | ns |
| SCLK Input Pulse-Width High/Low | t_{SCH}, t_{SCL} | | | $t_{SCK} / 2$ | | ns |
| MOSI Output Hold Time after SCLK Sample Edge | t_{MOH} | $C_L = 50pF$ | $t_{MCK} / 2$ - 25 | | | ns |
| MOSI Output Valid to Sample Edge | t_{MOV} | | $t_{MCK} / 2$ - 25 | | | ns |
| MISO Input Valid to SCLK Sample Edge Rise/Fall Setup | t_{MIS} | | 30 | | | ns |
| MISO Input to SCLK Sample Edge Rise/Fall Hold | t_{MIH} | | 0 | | | ns |

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ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = V_{DD(MIN)}$ to $V_{DD(MAX)}$, $V_{DDIO} = 2.7V$ to $3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|--------|------------|-----------------------|-----|----------------|-------|
| SCLK Inactive to MOSI Inactive | tMLH | | $t_{MCK} / 2$ - 25 | | | ns |
| MOSI Input to SCLK Sample Edge Rise/Fall Setup | tSIS | | 30 | | | ns |
| MOSI Input from SCLK Sample Edge Transition Hold | tSIH | | $t_{CK} + 25$ | | | ns |
| MISO Output Valid after SCLK Shift Edge Transition | tSOV | | | | $3t_{CK} + 25$ | ns |
| \overline{SS} Inactive | tSSH | | $t_{CK} + 25$ | | | ns |
| SCLK Inactive to \overline{SS} Rising | tSD | | $t_{CK} + 25$ | | | ns |
| MISO Output Disabled after \overline{CS} Edge Rise | tSLH | | | | $2t_{CK} + 50$ | ns |
| \overline{SS} Active to First Shift Edge | tSSE | | $4t_{CK}$ | | | ns |

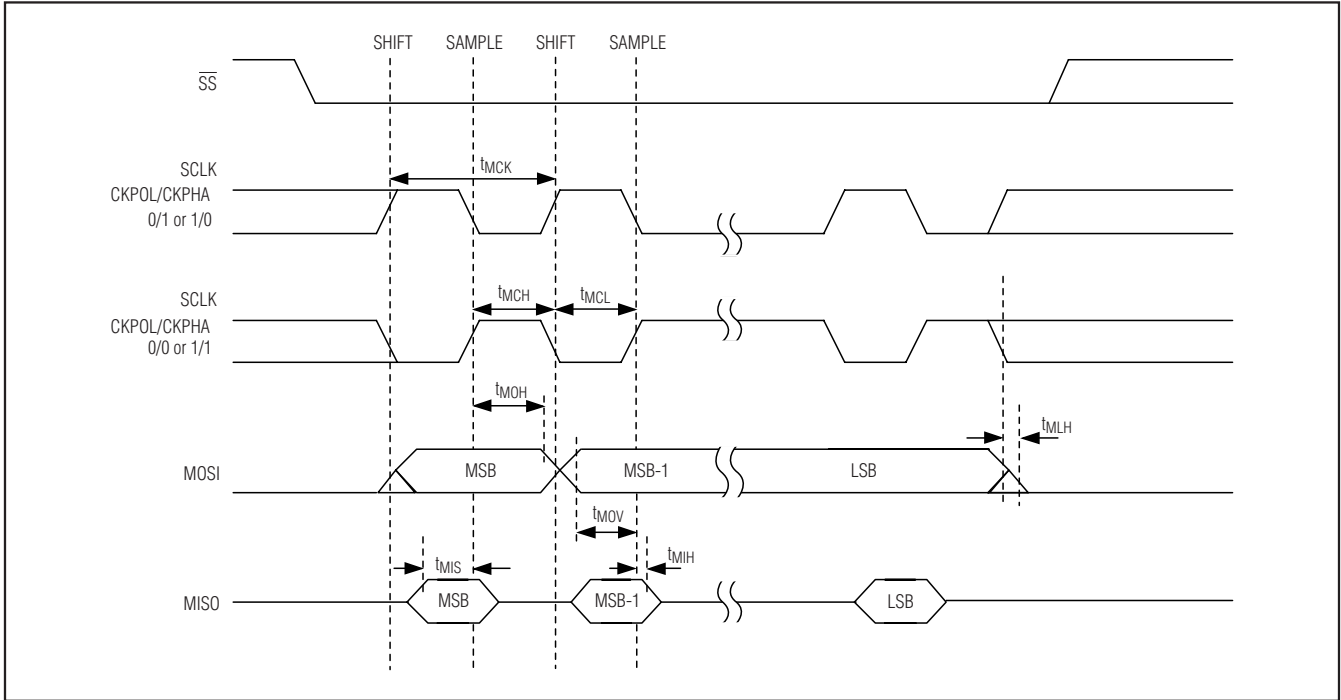
Note 1: Specifications to $-40^{\circ}C$ are guaranteed by design and not production tested.

Note 2: Guaranteed by design.

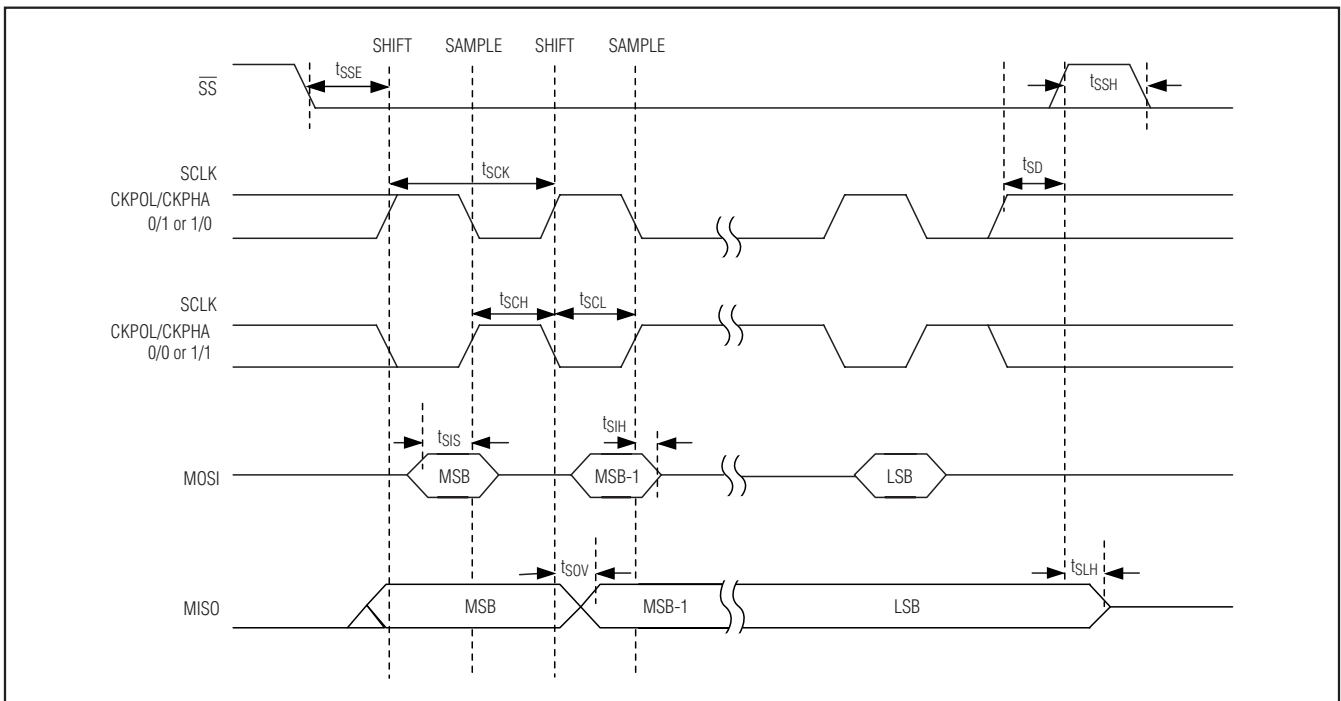
Note 3: Measured on the V_{DD} pin with $V_{DD} = 2.75V$ and not in reset.

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SPI Master Timing



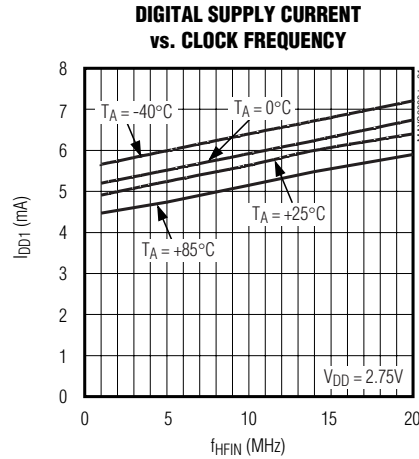
SPI Slave Timing



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Typical Operating Characteristics



Pin Description

| PIN | | | NAME | FUNCTION |
|---------|--------|--------|---------------------------|---|
| TQFN-EP | QFN-EP | LQFP | | |
| 40 | 49 | 70 | V _{DD} | Digital Supply Voltage |
| 22 | 27 | 36, 62 | V _{DDIO} | I/O Supply Voltage |
| 23, 35 | 28, 42 | 39, 63 | GND | Ground |
| 45 | 54 | 83 | V _{LCD} | LCD Bias-Control Voltage. Highest LCD drive voltage used with static bias. Connected to an external source. |
| 46 | 55 | 84 | V _{LCD1} | LCD Bias, Voltage 1. LCD drive voltage used with 1/2 and 1/3 LCD bias. An internal resistor- divider sets the voltage. External resistors and capacitors can be used to change the LCD voltage or drive capability at this pin. |
| 47 | 56 | 85 | V _{LCD2} | LCD Bias, Voltage 2. LCD drive voltage used with 1/3 LCD bias. An internal resistor-divider sets the voltage. External resistors and capacitors can be used to change LCD voltage or drive capability at this pin. |
| 48 | 57 | 86 | V _{ADJ} | LCD Adjustment Voltage. Connect to an external resistor to provide external control of the LCD contrast. Leave disconnected for internal contrast adjustment. |
| 28 | 33 | 50 | $\overline{\text{RESET}}$ | Digital, Active-Low, Reset Input/Output. The CPU is held in reset when this is low and begins executing from the reset vector when released. The pin includes pullup current source and should be driven by an open-drain, external source capable of sinking in excess of 2mA. This pin is driven low as an output when an internal reset condition occurs. |
| 42 | 51 | 76 | HFXIN | High-Frequency Crystal Input. Connect an external crystal or resonator between HFXIN and HFXOUT as the high-frequency system clock. Alternatively, HFXIN is the input for an external, high-frequency clock source when HFXOUT is floating. |
| 41 | 50 | 71 | HFXOUT | High-Frequency Crystal Output/Input. Connect an external crystal or resonator between HFXIN and HFXOUT as the high-frequency system clock. Alternatively, float HFXOUT when an external, high-frequency clock source is connected to the HFXIN pin. |

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Pin Description (continued)

| PIN | | | NAME | FUNCTION | | | | | |
|---------|-----------------|------------------|------------------------|---|--------|---------|------|---------------------|--------|
| TQFN-EP | QFN-EP | LQFP | | | | | | | |
| 29 | 34 | 52 | 32KIN | 32kHz Crystal Input. Connect an external, 32kHz watch crystal between 32KIN and 32KOUT as the low-frequency system clock. Alternatively, 32KIN is the input for an external, 32kHz clock source when 32KOUT is floating. | | | | | |
| 30 | 35 | 53 | 32KOUT | 32kHz Crystal Output/Input. Connect an external, 32kHz watch crystal between 32KIN and 32KOUT as the low-frequency system clock. Alternatively, float 32KOUT when an external, 32kHz clock source is connected to the 32KIN pin. | | | | | |
| 1–8 | 66, 67, 68; 1–5 | 97, 98, 3–8 | P1.0–P1.7; SEG8–SEG15 | General-Purpose, 8-Bit, Digital, I/O, Type-C Port; LCD Segment-Driver Output. These port pins function as both bidirectional I/O pins and LCD segment-drive outputs. All port pins are defaulted as input with weak pullup after a reset. Enabling a pin's LCD function disables the general-purpose I/O on the pin. Setting the PCF1 bit enables the LCD for all pins on this port and disables the general-purpose I/O function on all pins. | | | | | |
| | | | | 56-PIN | 68-PIN | 100-PIN | PORT | ALTERNATE FUNCTION | |
| | | | | 1 | 66 | 97 | P1.0 | SEG8 | |
| | | | | 2 | 67 | 98 | P1.1 | SEG9 | |
| | | | | 3 | 68 | 3 | P1.2 | SEG10 | |
| | | | | 4 | 1 | 4 | P1.3 | SEG11 | |
| | | | | 5 | 2 | 5 | P1.4 | SEG12 | |
| | | | | 6 | 3 | 6 | P1.5 | SEG13 | |
| | | | | 7 | 4 | 7 | P1.6 | SEG14 | |
| | | | | 8 | 5 | 8 | P1.7 | SEG15 | |
| 9–12 | 6–13 | 9, 10, 11, 14–18 | P2.0–P2.7; SEG16–SEG23 | General-Purpose, 8-Bit, Digital, I/O, Type-C Port; LCD Segment-Driver Output. These port pins function as both bidirectional I/O pins and LCD segment-drive outputs. All port pins are defaulted as input with weak pullup after a reset. Enabling a pin's LCD function disables the general-purpose I/O on the pin. Setting the PCF2 bit enables the LCD for all pins on this port and disables the general-purpose I/O function on all pins. | | | | | |
| | | | | 56-PIN | 68-PIN | 100-PIN | PORT | ALTERNATE FUNCTIONS | |
| | | | | | | | | 56-PIN | 68-PIN |
| | | | | — | 6 | 9 | P2.0 | — | SEG16 |
| | | | | — | 7 | 10 | P2.1 | — | SEG17 |
| | | | | — | 8 | 11 | P2.2 | — | SEG18 |
| | | | | — | 9 | 14 | P2.3 | — | SEG19 |
| | | | | 9 | 10 | 15 | P2.4 | SEG16 | SEG20 |
| | | | | 10 | 11 | 16 | P2.5 | SEG17 | SEG21 |
| | | | | 11 | 12 | 17 | P2.6 | SEG18 | SEG22 |
| 12 | 13 | 18 | P2.7 | SEG19 | SEG23 | | | | |

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Pin Description (continued)

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| PIN | | | NAME | FUNCTION | | | | | | |
|---------|--------|-------------------------|---|--|------------|---------|----------|---------------------|---------------------|------|
| TQFN-EP | QFN-EP | LQFP | | | | | | | | |
| 13–16 | 14–21 | 19–23, 27, 28, 29 | P3.0– P3.7; SEGx; INT4– INT7 | <p>General-Purpose, Digital, I/O, Type-D Port; LCD Segment-Driver Output; External Edge-Selectable Interrupt. This port functions as both bidirectional I/O pins and LCD segment-drive outputs. All port pins are defaulted as inputs with weak pullups after a reset. The port pads can be configured as an external interrupt for pins 7 to 4. If the external interrupt is enabled, the LCD function on the associated pin is disabled. Setting the PCF3 bit enables the LCD for all pins on this port and disables the general-purpose I/O function on all pins.</p> <p>It is possible to mix the LCD and interrupt functions on the same port. To do this, the interrupt enable must be established prior to setting the PCF0 bit. Care must be taken not to enable the external interrupt while the LCD is in normal operational mode, as this could result in potentially harmful contention between the LCD controller output and the external source connected to the interrupt input.</p> | | | | | | |
| | | | | 56-PIN | 68-PIN | 100-PIN | PORT | ALTERNATE FUNCTIONS | | |
| | | | | 56-PIN | | 68-PIN | | | | |
| | | | | — | 14 | 19 | P3.0 | — | SEG24 | |
| | | | | — | 15 | 20 | P3.1 | — | SEG25 | |
| | | | | — | 16 | 21 | P3.2 | — | SEG26 | |
| | | | | — | 17 | 22 | P3.3 | — | SEG27 | |
| | | | | 13 | 18 | 23 | P3.4 | SEG20/INT4 | SEG28/INT4 | |
| | | | | 14 | 19 | 27 | P3.5 | SEG21/INT5 | SEG29/INT5 | |
| | | | | 15 | 20 | 28 | P3.6 | SEG22/INT6 | SEG30/INT6 | |
| 16 | 21 | 29 | P3.7 | SEG23/INT7 | SEG31/INT7 | | | | | |
| 17–21 | 22–26 | 30–34 | SEGx; COM3– COM0 | <p>LCD Segment-Driver Output; LCD Common-Drive Output. The selection of a pin function as either segment or its alternative common-mode signal is controlled by the choice of duty cycle (DUTY1:0).</p> | | | | | | |
| | | | | 56-PIN | 68-PIN | 100-PIN | FUNCTION | | ALTERNATE FUNCTIONS | |
| | | | | 56-PIN | | 68-PIN | | 100-PIN | | |
| | | | | 17 | 22 | 30 | SEG24 | SEG32 | SEG32 | — |
| | | | | 18 | 23 | 31 | SEG25 | SEG33 | COM3 | COM3 |
| | | | | 19 | 24 | 32 | SEG26 | SEG34 | COM2 | COM2 |
| 20 | 25 | 33 | SEG27 | SEG35 | COM1 | COM1 | | | | |
| 21 | 26 | 34 | — | COM0 | COM0 | — | | | | |
| 24–27 | 29–32 | 40–43 | P4.0– P4.3; TCK/TDI/ TMS/ TDO; INT8, INT9 | <p>General-Purpose, Digital, I/O, Type-D Port; Debug Port Signal; External Edge-Selectable Interrupt. Pins default to JTAG on POR; other functions must be enabled from software.</p> | | | | | | |
| | | | | 56-PIN | 68-PIN | 100-PIN | PORT | ALTERNATE FUNCTIONS | | |
| | | | | 24 | 29 | 40 | P4.0 | TCK | INT8 | |
| | | | | 25 | 30 | 41 | P4.1 | TDI | INT9 | |
| | | | | 26 | 31 | 42 | P4.2 | TMS | — | |
| 27 | 32 | 43 | P4.3 | TDO | — | | | | | |

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Pin Description (continued)

| PIN | | | NAME | FUNCTION |
|---------|--------|------|-----------------------|--|
| TQFN-EP | QFN-EP | LQFP | | |
| — | 36 | 54 | P5.2/RX1/ INT10 | General-Purpose, Digital, I/O, Type-D Port; Serial Port 1 Receive; External Edge-Selectable Interrupt 10 |
| — | 37 | 56 | P5.3/TX1/ INT11 | General-Purpose, Digital, I/O, Type-D Port; Serial Port 1 Transmit; External Edge-Selectable Interrupt 11 |
| 31 | 38 | 57 | P5.4/ \overline{SS} | General-Purpose, Digital, I/O, Type-C Port; Active-Low, SPI, Slave-Select Input. Becomes the slave-select input in SPI mode. |
| 32 | 39 | 58 | P5.5; MOSI | General-Purpose, Digital, I/O, Type-C Port; SPI, Master-Out Slave-In Output. Data is clocked out of the microcontroller on SCLK's falling edge and into the slave device on SCLK's rising edge. Becomes MOSI input in SPI mode. |
| 33 | 40 | 59 | P5.6; SCLK | General-Purpose, Digital, I/O, Type-C Port; SPI, Clock Output. Becomes SCLK input in slave mode but limited to SYSCLK / 8. |
| 34 | 41 | 60 | P5.7/ MISO | General-Purpose, Digital, I/O, Type-C Port; SPI, Master-In Slave-Out Input. Data is clocked out of the slave on SCLK's falling edge and into the microcontroller on SCLK's rising edge. Becomes MISO output in slave mode. |
| 36 | 43 | 64 | P6.0/T1B/ INT12 | General-Purpose, Digital, I/O, Type-D Port; Timer 1 Alternative Output (PWM); External Edge-Selectable Interrupt 12 |
| 37 | 44 | 65 | P6.1/T1/ INT13 | General-Purpose, Digital, I/O Type-D Port; Timer 1 Output (PWM); External Edge-Selectable Interrupt 13 |
| — | 45 | 66 | P6.2/T2B/ OW_OUT | General-Purpose, Digital, I/O, Type-D Port; Timer 2 Alternative Output (PWM); 1-Wire Data Output |
| — | 46 | 67 | P6.3/T2/ OW_IN | General-Purpose, Digital, I/O, Type-D Port; Timer 2 Output (PWM); 1-Wire Data Input |
| 38 | 47 | 68 | P6.4/T0B/ WKOUT0 | General-Purpose, Digital, I/O, Type-C Port; Timer 0 Alternative Output (PWM); Wakeup Output 0 |
| 39 | 48 | 69 | P6.5/T0/ WKOUT1 | General-Purpose, Digital, I/O, Type-C Port; Timer 0 Output (PWM); Wakeup Output 1 |
| 43 | 52 | 81 | P7.0/TX0/ INT14 | General-Purpose, Digital, I/O, Type-D Port; Serial Port 0 Transmit; External, Edge-Selectable Interrupt 14 |
| 44 | 53 | 82 | P7.1/RX0/ INT15 | General-Purpose, Digital, I/O, Type-D Port; Serial Port 0 Receive; External Edge-Selectable Interrupt 15 |

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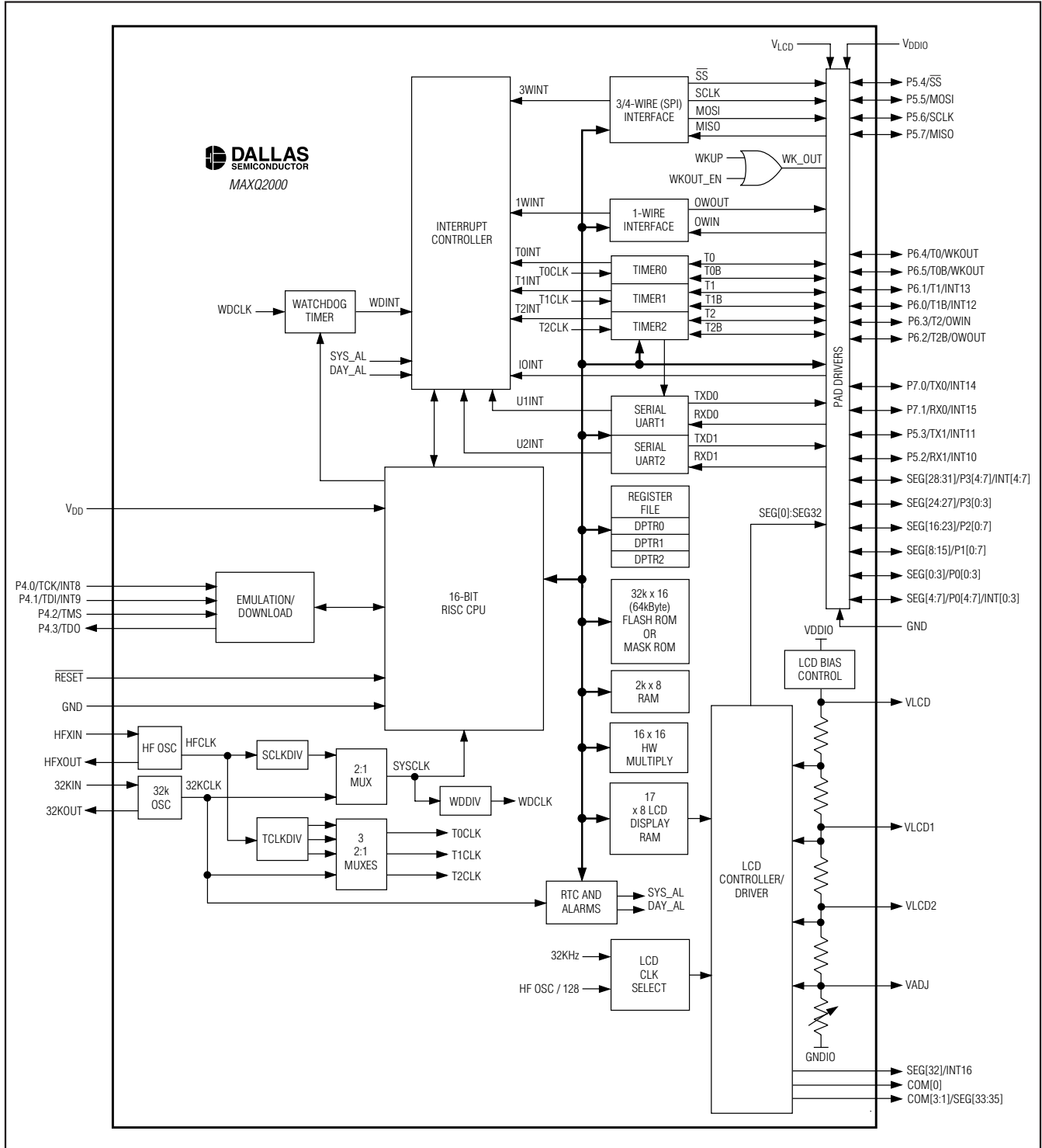
Pin Description (continued)

MAXQ2000

| PIN | | | NAME | FUNCTION | | | | | |
|---------|--------|--|---------------------------------------|--|--------|---------|------|---------------------|------|
| TQFN-EP | QFN-EP | LQFP | | | | | | | |
| 49–56 | 58–65 | 89–96 | P0.0–P0.7; SEG0–SEG7; INT0–INT3 | <p>General-Purpose, Digital, I/O, Type-D Port; LCD Segment-Driver Output; External Edge-Selectable Interrupt. This port functions as both bidirectional I/O pins and LCD segment-drive outputs. All port pins are defaulted as input with weak pullup after a reset. The port pads can be configured as an external interrupt for pins 7 to 4. If the external interrupt is enabled, the LCD function on the associated pin is disabled. Setting the PCF0 bit enables the LCD for all pins on this port and disables the general-purpose I/O function on all pins.</p> <p>It is possible to mix the LCD and interrupt functions on the same port. To do this, the interrupt enable must be established prior to setting the PCF0 bit. Care must be taken not to enable the external interrupt while the LCD is in normal operational mode, as this could result in potentially harmful contention between the LCD controller output and the external source connected to the interrupt input.</p> | | | | | |
| | | | | 56-PIN | 68-PIN | 100-PIN | PORT | ALTERNATE FUNCTIONS | |
| | | | | 49 | 58 | 89 | P0.0 | SEG0 | — |
| | | | | 50 | 59 | 90 | P0.1 | SEG1 | — |
| | | | | 51 | 60 | 91 | P0.2 | SEG2 | — |
| | | | | 52 | 61 | 92 | P0.3 | SEG3 | — |
| | | | | 53 | 62 | 93 | P0.4 | SEG4 | INT0 |
| | | | | 54 | 63 | 94 | P0.5 | SEG5 | INT1 |
| | | | | 55 | 64 | 95 | P0.6 | SEG6 | INT2 |
| 56 | 65 | 96 | P0.7 | SEG7 | INT3 | | | | |
| — | — | 1, 2, 12, 13, 24, 25, 26, 35, 37, 38, 44–49, 51, 55, 61, 72–75, 77–80, 87, 88, 99, 100 | N.C. | <p>No Connection. These pins should not be connected.</p> | | | | | |
| — | — | — | EP | <p>Exposed Paddle. Exposed paddle is on the under side of the package. It should be left unconnected.</p> | | | | | |

Low-Power LCD Microcontroller

Block Diagram



Low-Power LCD Microcontroller

Detailed Description

The following is an introduction to the primary features of the microcontroller. More detailed descriptions of the device features can be found in the data sheets, errata sheets, and user's guides described later in the *Additional Documentation* section.

MAXQ Core Architecture

The MAXQ2000 is a low-cost, high-performance, CMOS, fully static, 16-bit RISC microcontroller with flash memory and an integrated 100- or 132-segment LCD controller. It is structured on a highly advanced, accumulator-based, 16-bit RISC architecture. Fetch and execution operations are completed in one cycle without pipelining, because the instruction contains both the op code and data. The result is a streamlined 20 million instructions-per-second (MIPS) microcontroller.

The highly efficient core is supported by a 16-level hardware stack, enabling fast subroutine calling and task switching. Data can be quickly and efficiently manipulated with three internal data pointers. Multiple data pointers allow more than one function to access data memory without having to save and restore data pointers each time. The data pointers can automatically increment or decrement following an operation, eliminating the need for software intervention. As a result, application speed is greatly increased.

Instruction Set

The instruction set is composed of fixed-length, 16-bit instructions that operate on registers and memory locations. The instruction set is highly orthogonal, allowing arithmetic and logical operations to use any register along with the accumulator. Special-function registers control the peripherals and are subdivided into register modules. The family architecture is modular, so that new devices and modules can reuse code developed for existing products.

The architecture is transport-triggered. This means that writes or reads from certain register locations can also cause side effects to occur. These side effects form the basis for the higher-level op codes defined by the assembler, such as ADDC, OR, JUMP, etc. The op codes are actually implemented as MOVE instructions between certain register locations, while the assembler handles the encoding, which need not be a concern to the programmer.

The 16-bit instruction word is designed for efficient execution. Bit 15 indicates the format for the source field of the instruction. Bits 0 to 7 of the instruction represent the source for the transfer. Depending on the value of the

format field, this can either be an immediate value or a source register. If this field represents a register, the lower four bits contain the module specifier and the upper four bits contain the register index in that module.

Bits 8 to 14 represent the destination for the transfer. This value always represents a destination register, with the lower four bits containing the module specifier and the upper three bits containing the register subindex within that module. Any time that it is necessary to directly select one of the upper 24 registers as a destination, the prefix register, PFX, is needed to supply the extra destination bits. This prefix register write is inserted automatically by the assembler and requires only one additional execution cycle.

Memory Organization

The device incorporates several memory areas:

- 4kB utility ROM,
- 32kWords of flash memory for program storage,
- 1kWord of SRAM for storage of temporary variables, and
- 16-level stack memory for storage of program return addresses and general-purpose use.

The memory is arranged by default in a Harvard architecture, with separate address spaces for program and data memory. A special mode allows data memory to be mapped into program space, permitting code execution from data memory. In addition, another mode allows program memory to be mapped into data space, permitting code constants to be accessed as data memory.

The incorporation of flash memory allows the devices to be reprogrammed, eliminating the expense of throwing away one-time programmable devices during development and field upgrades. Flash memory can be password protected with a 16-word key, denying access to program memory by unauthorized individuals.

A pseudo-Von Neumann memory map can also be enabled. This places the utility ROM, code, and data memory into a single contiguous memory map. This is useful for applications that require dynamic program modification or unique memory configurations.

Stack Memory

A 16-bit-wide internal stack provides storage for program return addresses and general-purpose use. The stack is used automatically by the processor when the CALL, RET, and RETI instructions are executed and interrupts serviced. The stack can also be used explicitly to store and retrieve data by using the PUSH, POP, and POPI instructions.

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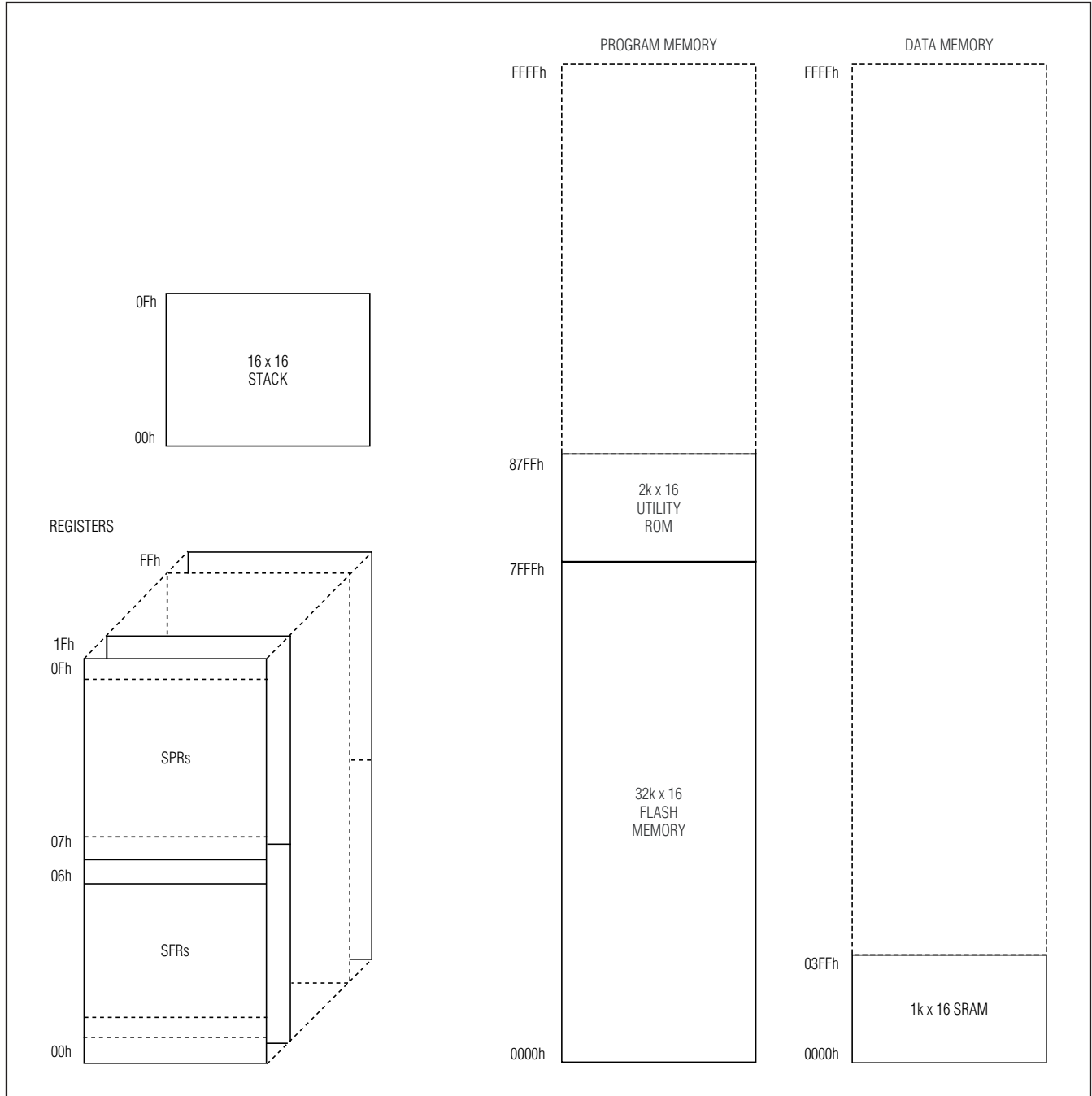


Figure 1. Memory Map

Low-Power LCD Microcontroller

On reset, the stack pointer, SP, initializes to the top of the stack (0Fh). The CALL, PUSH, and interrupt-vectoring operations increment SP, then store a value at the location pointed to by SP. The RET, RETI, POP, and POPI operations retrieve the value @SP and then decrement SP.

Utility ROM

The utility ROM is a 4kB block of internal ROM memory that defaults to a starting address of 8000h. The utility ROM consists of subroutines that can be called from application software. These include:

- In-system programming (bootstrap loader) over JTAG or UART interfaces
- In-circuit debug routines
- Test routines (internal memory tests, memory loader, etc.)
- User-callable routines for in-application flash programming and fast table lookup

Following any reset, execution begins in the utility ROM. The ROM software determines whether the program execution should immediately jump to location 0000h, the start of user-application code, or to one of the special routines mentioned. Routines within the utility ROM are user-accessible and can be called as subroutines by the application software. More information on the utility ROM contents is contained in the *MAXQ Family User's Guide: MAXQ2000 Supplement*.

Some applications require protection against unauthorized viewing of program code memory. For these applications, access to in-system programming, in-application programming, or in-circuit debugging functions is prohibited until a password has been supplied. The password is defined as the 16 words of physical program memory at addresses x0010h to x001Fh.

A single password lock (PWL) bit is implemented in the SC register. When the PWL is set to one (power-on reset default), the password is required to access the utility ROM, including in-circuit debug and in-system programming routines that allow reading or writing of internal memory. When PWL is cleared to zero, these utilities are fully accessible without password. The password is automatically set to all ones following a mass erase.

Programming

The flash memory of the microcontroller can be programmed by two different methods: in-system programming and in-application programming. Both

methods afford great flexibility in system design as well as reduce the life-cycle cost of the embedded system. These features can be password protected to prevent unauthorized access to code memory.

In-System Programming

An internal bootstrap loader allows the device to be reloaded over a simple JTAG interface. As a result, software can be upgraded in-system, eliminating the need for a costly hardware retrofit when updates are required. Remote software uploads are possible that enable physically inaccessible applications to be frequently updated. The interface hardware can be a JTAG connection to another microcontroller, or a connection to a PC serial port using a serial-to-JTAG converter such as the MAXQJTAG-001, available from Maxim Integrated Products. If in-system programmability is not required, a commercial gang programmer can be used for mass programming.

Activating the JTAG interface and loading the test access port (TAP) with the system programming instruction invokes the bootstrap loader. Setting the SPE bit to 1 during reset through the JTAG interface executes the bootstrap-loader-mode program that resides in the utility ROM. When programming is complete, the bootstrap loader can clear the SPE bit and reset the device, allowing the device to bypass the utility ROM and begin execution of the application software.

The following bootstrap loader functions are supported:

- Load
- Dump
- CRC
- Verify
- Erase

Optionally, the bootstrap loader can be invoked by the application code. In this mode, the application software would configure the SPE and PSS bits for UART communication, then jump to the start of the utility ROM. In this way, the bootstrap loader can be accessed through another UART-enabled peripheral, or a PC serial port through an RS-232 transceiver such as the MAX232. Because the bootstrap loader defaults to the JTAG configuration on reset, the UART versus JTAG selection must be made from the application code. As a result, bootstrap loader access through the UART is not possible in an unprogrammed device.

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In-Application Programming

The in-application programming feature allows the microcontroller to modify its own flash program memory while simultaneously executing its application software. This allows on-the-fly software updates in mission-critical applications that cannot afford downtime. Alternatively, it allows the application to develop custom loader software that can operate under the control of the application software. The utility ROM contains user-accessible flash programming functions that erase and program flash memory. These functions are described in detail in the user's guide supplement for this device.

Register Set

Most functions of the device are controlled by sets of registers. These registers provide a working space for memory operations as well as configuring and addressing peripheral registers on the device. Registers are divided into two major types: system registers and peripheral registers. The common register set, also known as the system registers, includes the ALU, accumulator registers, data pointers, interrupt vectors and control, and stack pointer. The peripheral registers define additional functionality that may be included by different products based on the MAXQ architecture. This functionality is broken up into discrete modules so that only the features required for a given product need to be included. Tables 1 and 4 show the MAXQ2000 register set.

Table 1. System Register Map

| REGISTER INDEX | MODULE NAME (BASE SPECIFIER) | | | | | | |
|----------------|------------------------------|--------------|------------|-----------|------------|-------------|------------|
| | AP (8h) | A (9h) | PFX (Bh) | IP (Ch) | SP (Dh) | DPC (Eh) | DP (Fh) |
| 0xh | AP | A[0] | PFX | IP | — | — | — |
| 1xh | APC | A[1] | — | — | SP | — | — |
| 2xh | — | A[2] | — | — | IV | — | — |
| 3xh | — | A[3] | — | — | — | Offs | DP0 |
| 4xh | PSF | A[4] | — | — | — | DPC | — |
| 5xh | IC | A[5] | — | — | — | GR | — |
| 6xh | IMR | A[6] | — | — | LC0 | GRL | — |
| 7xh | — | A[7] | — | — | LC1 | BP | DP1 |
| 8xh | SC | A[8] | — | — | — | GRS | — |
| 9xh | — | A[9] | — | — | — | GRH | — |
| Axh | — | A[10] | — | — | — | GRXL | — |
| Bxh | <i>IIR</i> | A[11] | — | — | — | FP | — |
| Cxh | — | A[12] | — | — | — | — | — |
| Dxh | — | A[13] | — | — | — | — | — |
| Exh | CKCN | A[14] | — | — | — | — | — |
| Fxh | WDCN | A[15] | — | — | — | — | — |

Note: Names that appear in *italics* indicate that all bits of a register are read-only. Names that appear in **bold** indicate that a register is 16 bits wide. Registers in module AP are bit addressable.

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Table 2. System Register Bit Functions

| REGISTER | REGISTER BIT | | | | | | | | | | | | | | | | |
|-----------------|-----------------|-------|-------|-------|-------|-------|------|------|-------|-------|-------|-------|-------|-------------|-------|-------|-------------|
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| AP | | | | | | | | | | | | | | AP (4 bits) | | | |
| APC | | | | | | | | | CLR | IDS | | | | MOD2 | MOD1 | MOD0 | |
| PSF | | | | | | | | Z | S | | | GPF1 | GPF0 | OV | C | E | |
| IC | | | | | | | | | | | CGDS | | | | INS | IGE | |
| IMR | | | | | | | | IMS | | | | IM4 | IM3 | IM2 | IM1 | IM0 | |
| SC | | | | | | | | TAP | | | | CDA0 | | ROD | PWL | | |
| IIR | | | | | | | | IIS | | | | I14 | I13 | I12 | I11 | I10 | |
| CKCN | | | | | | | | | RGSL | RGMD | | STOP | SWB | PMME | CD1 | CD0 | |
| WDCN | | | | | | | | POR | EWDI | WD1 | WD0 | WDIF | WTRF | EWT | RWT | | |
| A[n] (0..15) | A[n] (16 bits) | | | | | | | | | | | | | | | | |
| PFX | PFX (16 bits) | | | | | | | | | | | | | | | | |
| IP | IP (16 bits) | | | | | | | | | | | | | | | | |
| SP | | | | | | | | | | | | | | | | | SP (4 bits) |
| IV | IV (16 bits) | | | | | | | | | | | | | | | | |
| LC[0] | LC[0] (16 bits) | | | | | | | | | | | | | | | | |
| LC[1] | LC[1] (16 bits) | | | | | | | | | | | | | | | | |
| Ofs | Ofs (8 bits) | | | | | | | | | | | | | | | | |
| DPC | | | | | | | | | | | | WBS2 | WBS1 | WBS0 | SDPS1 | SDPS0 | |
| GR | GR.15 | GR.14 | GR.13 | GR.12 | GR.11 | GR.10 | GR.9 | GR.8 | GR.7 | GR.6 | GR.5 | GR.4 | GR.3 | GR.2 | GR.1 | GR.0 | |
| GRL | | | | | | | | | GR.7 | GR.6 | GR.5 | GR.4 | GR.3 | GR.2 | GR.1 | GR.0 | |
| BP | BP (16 bits) | | | | | | | | | | | | | | | | |
| GRS | GR.7 | GR.6 | GR.5 | GR.4 | GR.3 | GR.2 | GR.1 | GR.0 | GR.15 | GR.14 | GR.13 | GR.12 | GR.11 | GR.10 | GR.9 | GR.8 | |
| GRH | | | | | | | | | GR.15 | GR.14 | GR.13 | GR.12 | GR.11 | GR.10 | GR.9 | GR.8 | |
| GRXL | GR.7 | GR.7 | GR.7 | GR.7 | GR.7 | GR.7 | GR.7 | GR.7 | GR.7 | GR.6 | GR.5 | GR.4 | GR.3 | GR.2 | GR.1 | GR.0 | |
| FP | FP (16 bits) | | | | | | | | | | | | | | | | |
| DP[0] | DP[0] (16 bits) | | | | | | | | | | | | | | | | |
| DP[1] | DP[1] (16 bits) | | | | | | | | | | | | | | | | |

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Table 3. System Register Bit Reset Values

| REGISTER | REGISTER BIT | | | | | | | | | | | | | | | |
|-----------------|--------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| AP | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| APC | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PSF | | | | | | | | | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| IC | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| IMR | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SC | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | s |
| IIR | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| CKCN | | | | | | | | | 0 | s | s | 0 | 0 | 0 | 0 | 0 |
| WDCN | | | | | | | | | s | s | 0 | 0 | 0 | 0 | 0 | 0 |
| A[n] (0..15) | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PFX | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| IP | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SP | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 |
| IV | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| LC[0] | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| LC[1] | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Offs | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| DPC | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0 |
| GR | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| GRL | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| BP | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| GRS | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| GRH | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| GRXL | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| FP | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| DP0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| DP1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

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MAXQ2000

Table 4. Peripheral Register Map

| REGISTER INDEX | MODULE NAME (BASE SPECIFIER) | | | | | |
|----------------|------------------------------|------------|-------------|--------------|-------------|----------|
| | M0 (x0h) | M1 (x1h) | M2 (x2h) | M3 (x3h) | M4 (x4h) | M5 (x5h) |
| 0xh | PO0 | PO4 | MCNT | T2CNA0 | T2CNA1 | — |
| 1xh | PO1 | PO5 | MA | T2H0 | T2H1 | — |
| 2xh | PO2 | PO6 | MB | T2RH0 | T2RH1 | — |
| 3xh | PO3 | PO7 | MC2 | T2CH0 | T2CH1 | — |
| 4xh | — | — | MC1 | — | T2CNA2 | — |
| 5xh | — | — | MC0 | SPIB | T2H2 | — |
| 6xh | EIF0 | EIF1 | SCON0 | SCON1 | T2RH2 | — |
| 7xh | EIE0 | EIE1 | SBUF0 | SBUF1 | T2CH2 | — |
| 8xh | <i>PI0</i> | <i>PI4</i> | SMD0 | SMD1 | T2CNB1 | — |
| 9xh | <i>PI1</i> | <i>PI5</i> | PR0 | PR1 | T2V1 | — |
| Axh | <i>PI2</i> | <i>PI6</i> | — | — | T2R1 | — |
| Bxh | <i>PI3</i> | <i>PI7</i> | MC1R | — | T2C1 | — |
| Cxh | EIES0 | EIES1 | MC0R | T2CNB0 | T2CNB2 | — |
| Dxh | — | — | LCRA | T2V0 | T2V2 | — |
| Exh | — | — | LCFG | T2R0 | T2R2 | — |
| Fxh | — | — | LCD16 | T2C0 | T2C2 | — |
| 10xh | PD0 | PD4 | LCD0 | T2CFG0 | T2CFG1 | — |
| 11xh | PD1 | PD5 | LCD1 | — | T2CFG2 | — |
| 12xh | PD2 | PD6 | LCD2 | — | — | — |
| 13xh | PD3 | PD7 | LCD3 | OWA | — | — |
| 14xh | — | — | LCD4 | OWD | — | — |
| 15xh | — | — | LCD5 | SPICN | — | — |
| 16xh | — | — | LCD6 | SPICF | — | — |
| 17xh | — | — | LCD7 | SPICK | — | — |
| 18xh | — | — | LCD8 | ICDT0 | — | — |
| 19xh | RCNT | — | LCD9 | ICDT1 | — | — |
| 1Axh | RTSS | — | LCD10 | ICDC | — | — |
| 1Bxh | RTSH | — | LCD11 | ICDF | — | — |
| 1Cxh | RTSL | — | LCD12 | ICDB | — | — |
| 1Dxh | RSSA | — | LCD13 | ICDA | — | — |
| 1Exh | RASH | SVS | LCD14 | ICDD | — | — |
| 1Fhx | RASL | WKO | LCD15 | TM | — | — |

Note: Names that appear in italics indicate that all bits of a register are read-only. Names that appear in bold indicate that a register is 16 bits wide.

Low-Power LCD Microcontroller

Table 5. Peripheral Register Bit Functions

| REGISTER | REGISTER BIT | | | | | | | | | | | | | | | |
|----------|--------------|------|-----|----|----|----|---|---|------|------|------|------|------|------|-----|------|
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| PO0 | | | | | | | | | | | | | | | | |
| PO1 | | | | | | | | | | | | | | | | |
| PO2 | | | | | | | | | | | | | | | | |
| PO3 | | | | | | | | | | | | | | | | |
| EIF0 | | | | | | | | | IE7 | IE6 | IE5 | IE4 | IE3 | IE2 | IE1 | IE0 |
| EIE0 | | | | | | | | | EX7 | EX6 | EX5 | EX4 | EX3 | EX2 | EX1 | EX0 |
| PI0 | | | | | | | | | | | | | | | | |
| PI1 | | | | | | | | | | | | | | | | |
| PI2 | | | | | | | | | | | | | | | | |
| PI3 | | | | | | | | | | | | | | | | |
| EIES0 | | | | | | | | | IT7 | IT6 | IT5 | IT4 | IT3 | IT2 | IT1 | IT0 |
| PD0 | | | | | | | | | | | | | | | | |
| PD1 | | | | | | | | | | | | | | | | |
| PD2 | | | | | | | | | | | | | | | | |
| PD3 | | | | | | | | | | | | | | | | |
| RCNT | WE | X32D | ACS | — | — | — | — | — | ALSF | ALDF | RDYE | RDY | BUSY | ASE | ADE | RTCE |
| RTSS | | | | | | | | | | | | | | | | |
| RTSH | | | | | | | | | | | | | | | | |
| RTSL | | | | | | | | | | | | | | | | |
| RSSA | | | | | | | | | | | | | | | | |
| RASH | | | | | | | | | | | | | | | | |
| RASL | | | | | | | | | | | | | | | | |
| PO4 | | | | | | | | | | | | | | | | |
| PO5 | | | | | | | | | | | | | | | | |
| PO6 | | | | | | | | | | | | | | | | |
| PO7 | | | | | | | | | | | | | | | | |
| EIF1 | | | | | | | | | IE15 | IE14 | IE13 | IE12 | IE11 | IE10 | IE9 | IE8 |
| EIE1 | | | | | | | | | EX15 | EX14 | EX13 | EX12 | EX11 | EX10 | EX9 | EX8 |
| PI4 | | | | | | | | | | | | | | | | |
| PI5 | | | | | | | | | | | | | | | | |
| PI6 | | | | | | | | | | | | | | | | |
| PI7 | | | | | | | | | | | | | | | | |
| EIES1 | | | | | | | | | IT15 | IT14 | IT13 | IT12 | IT11 | IT10 | IT9 | IT8 |
| PD4 | | | | | | | | | | | | | | | | |
| PD5 | | | | | | | | | | | | | | | | |
| PD6 | | | | | | | | | | | | | | | | |

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Table 5. Peripheral Register Bit Functions (continued)

| REGISTER | REGISTER BIT | | | | | | | | | | | | | | | | | |
|-------------|----------------|---------|---------|---------|---------|---------|--------|--------|---------------------|---------|---------|---------|---------|---------|--------|--------------|--|--|
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| PD7 | | | | | | | | | — | — | — | — | — | — | — | PD7 (2 bits) | | |
| SVS | | | | | | | | | SV67 | SV66 | SV65 | SV64 | — | — | — | SV71 | | |
| WKE0 | | | | | | | | | — | — | — | — | — | — | — | WKE1 | | |
| MCNT | | | | | | | | | OF | MCW | CLD | SQU | OPCS | MSUB | MMAC | SUS | | |
| MA | MA (16 bits) | | | | | | | | | | | | | | | | | |
| MB | MB (16 bits) | | | | | | | | | | | | | | | | | |
| MC2 | MC2 (16 bits) | | | | | | | | | | | | | | | | | |
| MC1 | MC1 (16 bits) | | | | | | | | | | | | | | | | | |
| MC0 | MC0 (16 bits) | | | | | | | | | | | | | | | | | |
| SCON0 | | | | | | | | | SMD/FE | SM1 | SM2 | REN | TB8 | RB8 | TI | RI | | |
| SBUF0 | | | | | | | | | SBUF0 (8 bits) | | | | | | | | | |
| SMD0 | | | | | | | | | — | — | — | — | — | — | ES10 | FEDE0 | | |
| PR0 | PR0 (16 bits) | | | | | | | | | | | | | | | | | |
| MC1R | MC1R (16 bits) | | | | | | | | | | | | | | | | | |
| MC0R | MC0R (16 bits) | | | | | | | | | | | | | | | | | |
| L CRA | — | — | — | DUTY1 | DUTY0 | FRM3 | FRM2 | FRM1 | FRM0 | LCCS | LRIG | LRA4 | LRA3 | LRA2 | LRA1 | LRA0 | | |
| L CFG | | | | | | | | | PCF3 | PCF2 | PCF1 | PCF0 | — | — | OPM | DPE | | |
| L CD[0..15] | | | | | | | | | LCD[0..15] (8 bits) | | | | | | | | | |
| T2CNA0 | | | | | | | | | ET2 | T2OE0 | T2POL0 | TR2L | TR2 | CPRL2 | SS2 | G2EN | | |
| T2H0 | | | | | | | | | T2V0.15 | T2V0.14 | T2V0.13 | T2V0.12 | T2V0.11 | T2V0.10 | T2V0.9 | T2V0.8 | | |
| T2RH0 | | | | | | | | | T2R0.15 | T2R0.14 | T2R0.13 | T2R0.12 | T2R0.11 | T2R0.10 | T2R0.9 | T2R0.8 | | |
| T2CH0 | | | | | | | | | T2C0.15 | T2C0.14 | T2C0.13 | T2C0.12 | T2C0.11 | T2C0.10 | T2C0.9 | T2C0.8 | | |
| SPIB | SPIB (16 bits) | | | | | | | | | | | | | | | | | |
| SCON1 | | | | | | | | | SMD/FE | SM1 | SM2 | REN | TB8 | RB8 | TI | RI | | |
| SBUF1 | | | | | | | | | SBUF1 (8 bits) | | | | | | | | | |
| SMD1 | | | | | | | | | — | — | — | — | — | — | ES11 | FEDE1 | | |
| PR1 | PR1 (16 bits) | | | | | | | | | | | | | | | | | |
| T2CNB0 | | | | | | | | | ET2L | T2OE1 | T2POL1 | TR2L | TF2 | TF2L | TCC2 | TC2L | | |
| T2V0 | T2V0.15 | T2V0.14 | T2V0.13 | T2V0.12 | T2V0.11 | T2V0.10 | T2V0.9 | T2V0.8 | T2V0.7 | T2V0.6 | T2V0.5 | T2V0.4 | T2V0.3 | T2V0.2 | T2V0.1 | T2V0.0 | | |
| T2R0 | T2R0.15 | T2R0.14 | T2R0.13 | T2R0.12 | T2R0.11 | T2R0.10 | T2R0.9 | T2R0.8 | T2R0.7 | T2R0.6 | T2R0.5 | T2R0.4 | T2R0.3 | T2R0.2 | T2R0.1 | T2R0.0 | | |
| T2C0 | T2C0.15 | T2C0.14 | T2C0.13 | T2C0.12 | T2C0.11 | T2C0.10 | T2C0.9 | T2C0.8 | T2C0.7 | T2C0.6 | T2C0.5 | T2C0.4 | T2C0.3 | T2C0.2 | T2C0.1 | T2C0.0 | | |
| T2CFG0 | | | | | | | | | T2CI | DIV2 | DIV1 | DIV0 | T2MD | CCF1 | CCF0 | C/T2 | | |
| OWA | | | | | | | | | — | — | — | — | — | A2 | A1 | A0 | | |
| OWD | | | | | | | | | OWD (8 bits) | | | | | | | | | |
| SPICN | | | | | | | | | STBY | SPIB | ROVR | WCOL | MODF | MODFE | MSTM | SPIEN | | |

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Table 5. Peripheral Register Bit Functions (continued)

| REGISTER | REGISTER BIT | | | | | | | | | | | | | | | |
|----------|--------------|---------|---------|---------|---------|---------|--------|---------|---------|---------|---------|---------|---------|--------|--------|--------|
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| SPIF | | | | | | | | ESPI1 | | | | | | CHR | CKPHA | CKPOL |
| SPICK | | | | | | | | CKR7 | CKR6 | CKR5 | CKR4 | CKR3 | CKR2 | CKR1 | CKR0 | CKR0 |
| ICDC | | | | | | | | DME | | REGE | | CMD3 | CMD2 | CMD1 | CMD0 | CMD0 |
| ICDF | | | | | | | | | | | | | PSS1 | PSS0 | SPE | TXC |
| ICDB | | | | | | | | | | | | | | | | |
| ICDA | | | | | | | | | | | | | | | | |
| ICDD | | | | | | | | | | | | | | | | |
| T2CNA1 | | | | | | | | ET2 | T2OE0 | T2POL0 | TR2L | TR2 | CPRL2 | SS2 | G2EN | G2EN |
| T2H1 | | | | | | | | T2V1.15 | T2V1.14 | T2V1.13 | T2V1.12 | T2V1.11 | T2V1.10 | T2V1.9 | T2V1.8 | T2V1.8 |
| T2RH1 | | | | | | | | T2R1.15 | T2R1.14 | T2R1.13 | T2R1.12 | T2R1.11 | T2R1.10 | T2R1.9 | T2R1.8 | T2R1.8 |
| T2CH1 | | | | | | | | T2C1.15 | T2C1.14 | T2C1.13 | T2C1.12 | T2C1.11 | T2C1.10 | T2C1.9 | T2C1.8 | T2C1.8 |
| T2CNA2 | | | | | | | | ET2 | T2OE0 | T2POL0 | TR2L | TR2 | CPRL2 | SS2 | G2EN | G2EN |
| T2H2 | | | | | | | | T2V2.15 | T2V2.14 | T2V2.13 | T2V2.12 | T2V2.11 | T2V2.10 | T2V2.9 | T2V2.8 | T2V2.8 |
| T2RH2 | | | | | | | | T2R2.15 | T2R2.14 | T2R2.13 | T2R2.12 | T2R2.11 | T2R2.10 | T2R2.9 | T2R2.8 | T2R2.8 |
| T2CH2 | | | | | | | | T2C2.15 | T2C2.14 | T2C2.13 | T2C2.12 | T2C2.11 | T2C2.10 | T2C2.9 | T2C2.8 | T2C2.8 |
| T2CNB1 | | | | | | | | ET2L | T2OE1 | T2POL1 | TR2L | TF2 | TF2L | TCC2 | TC2L | TC2L |
| T2V1 | T2V1.15 | T2V1.14 | T2V1.13 | T2V1.12 | T2V1.11 | T2V1.10 | T2V1.9 | T2V1.8 | T2V1.7 | T2V1.6 | T2V1.5 | T2V1.4 | T2V1.3 | T2V1.2 | T2V1.1 | T2V1.0 |
| T2R1 | T2R1.15 | T2R1.14 | T2R1.13 | T2R1.12 | T2R1.11 | T2R1.10 | T2R1.9 | T2R1.8 | T2R1.7 | T2R1.6 | T2R1.5 | T2R1.4 | T2R1.3 | T2R1.2 | T2R1.1 | T2R1.0 |
| T2C1 | T2C1.15 | T2C1.14 | T2C1.13 | T2C1.12 | T2C1.11 | T2C1.10 | T2C1.9 | T2C1.8 | T2C1.7 | T2C1.6 | T2C1.5 | T2C1.4 | T2C1.3 | T2C1.2 | T2C1.1 | T2C1.0 |
| T2CNB2 | | | | | | | | ET2L | T2OE1 | T2POL1 | TR2L | TF2 | TF2L | TCC2 | TC2L | TC2L |
| T2V2 | T2V2.15 | T2V2.14 | T2V2.13 | T2V2.12 | T2V2.11 | T2V2.10 | T2V2.9 | T2V2.8 | T2V2.7 | T2V2.6 | T2V2.5 | T2V2.4 | T2V2.3 | T2V2.2 | T2V2.1 | T2V2.0 |
| T2R2 | T2R2.15 | T2R2.14 | T2R2.13 | T2R2.12 | T2R2.11 | T2R2.10 | T2R2.9 | T2R2.8 | T2R2.7 | T2R2.6 | T2R2.5 | T2R2.4 | T2R2.3 | T2R2.2 | T2R2.1 | T2R2.0 |
| T2C2 | T2C2.15 | T2C2.14 | T2C2.13 | T2C2.12 | T2C2.11 | T2C2.10 | T2C2.9 | T2C2.8 | T2C2.7 | T2C2.6 | T2C2.5 | T2C2.4 | T2C2.3 | T2C2.2 | T2C2.1 | T2C2.0 |
| T2CFG1 | | | | | | | | T2C1 | DIV2 | DIV1 | DIV0 | DIV0 | T2MD | CCF1 | CCF0 | C/T2 |
| T2CFG2 | | | | | | | | T2C1 | DIV2 | DIV1 | DIV0 | DIV0 | T2MD | CCF1 | CCF0 | C/T2 |

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Table 6. Peripheral Register Reset Values

| REGISTER | REGISTER BIT | | | | | | | | | | | | | | | |
|----------|--------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| PO0 | | | | | | | | | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| PO1 | | | | | | | | | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| PO2 | | | | | | | | | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| PO3 | | | | | | | | | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| EIF0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| EIE0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PI0 | | | | | | | | | s | s | s | s | s | s | s | s |
| PI1 | | | | | | | | | s | s | s | s | s | s | s | s |
| PI2 | | | | | | | | | s | s | s | s | s | s | s | s |
| PI3 | | | | | | | | | s | s | s | s | s | s | s | s |
| EIES0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PD0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PD1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PD2 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PD3 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| RCNT | 0 | s | s | 0 | 0 | 0 | 0 | 0 | s | s | 0 | 0 | 1 | s | s | s |
| RTSS | | | | | | | | | s | s | s | s | s | s | s | s |
| RTSH | s | s | s | s | s | s | s | s | s | s | s | s | s | s | s | s |
| RTSL | s | s | s | s | s | s | s | s | s | s | s | s | s | s | s | s |
| RSSA | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| RASH | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| RASL | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PO4 | | | | | | | | | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 |
| PO5 | | | | | | | | | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| PO6 | | | | | | | | | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| PO7 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
| EIF1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| EIE1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PI4 | | | | | | | | | 0 | 0 | 0 | s | s | s | s | s |
| PI5 | | | | | | | | | s | s | s | s | s | s | s | s |
| PI6 | | | | | | | | | s | s | s | s | s | s | s | s |
| PI7 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | s | s |
| EIES1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PD4 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PD5 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PD6 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PD7 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SVS | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| WKO | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

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Table 6. Peripheral Register Reset Values (continued)

| REGISTER | REGISTER BIT | | | | | | | | | | | | | | | |
|------------|--------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| MCNT | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| MA | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| MB | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| MC2 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| MC1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| MC0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SCON0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SBUF0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SMD0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PR0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| MC1R | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| MC0R | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| LCRA | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| LCFG | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| LCD[0..15] | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CNA0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2H0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2RH0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CH0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SPIB | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SCON1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SBUF1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SMD1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PR1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CNB0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2V0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2R0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2C0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CFG0 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| OWA | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| OWD | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SPICN | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SPICF | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| SPICK | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| ICDC | | | | | | | | | s | s | s | s | s | s | s | s |
| ICDF | | | | | | | | | s | s | s | s | s | s | s | s |
| ICDB | | | | | | | | | s | s | s | s | s | s | s | s |
| ICDA | s | s | s | s | s | s | s | s | s | s | s | s | s | s | s | s |
| ICDD | s | s | s | s | s | s | s | s | s | s | s | s | s | s | s | s |
| T2CNA1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

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Table 6. Peripheral Register Reset Values (continued)

| REGISTER | REGISTER BIT | | | | | | | | | | | | | | | |
|----------|--------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| T2H1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2RH1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CH1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CNA2 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2H2 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2RH2 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CH2 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CNB1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2V1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2R1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2C1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CNB2 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2V2 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2R2 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2C2 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CFG1 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| T2CFG2 | | | | | | | | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Low-Power LCD Microcontroller

System Timing

For maximum versatility, the MAXQ2000 generates its internal system clock from one of five possible sources:

- Internal ring oscillator
- External high-frequency crystal or ceramic resonator, using an internal oscillator
- External high-frequency clock source
- External 32kHz crystal or ceramic resonator, using an internal oscillator
- External 32kHz clock source

A crystal warmup counter enhances operational reliability. Each time the external crystal oscillation must restart, such as after exiting Stop mode, the device initiates a crystal warmup period of 65,536 oscillations. This allows time for the crystal amplitude and frequency to stabilize before using it as a clock source. While in the warmup mode, the device can begin operation from the internal ring oscillator and automatically switch back to the crystal as soon as it is ready.

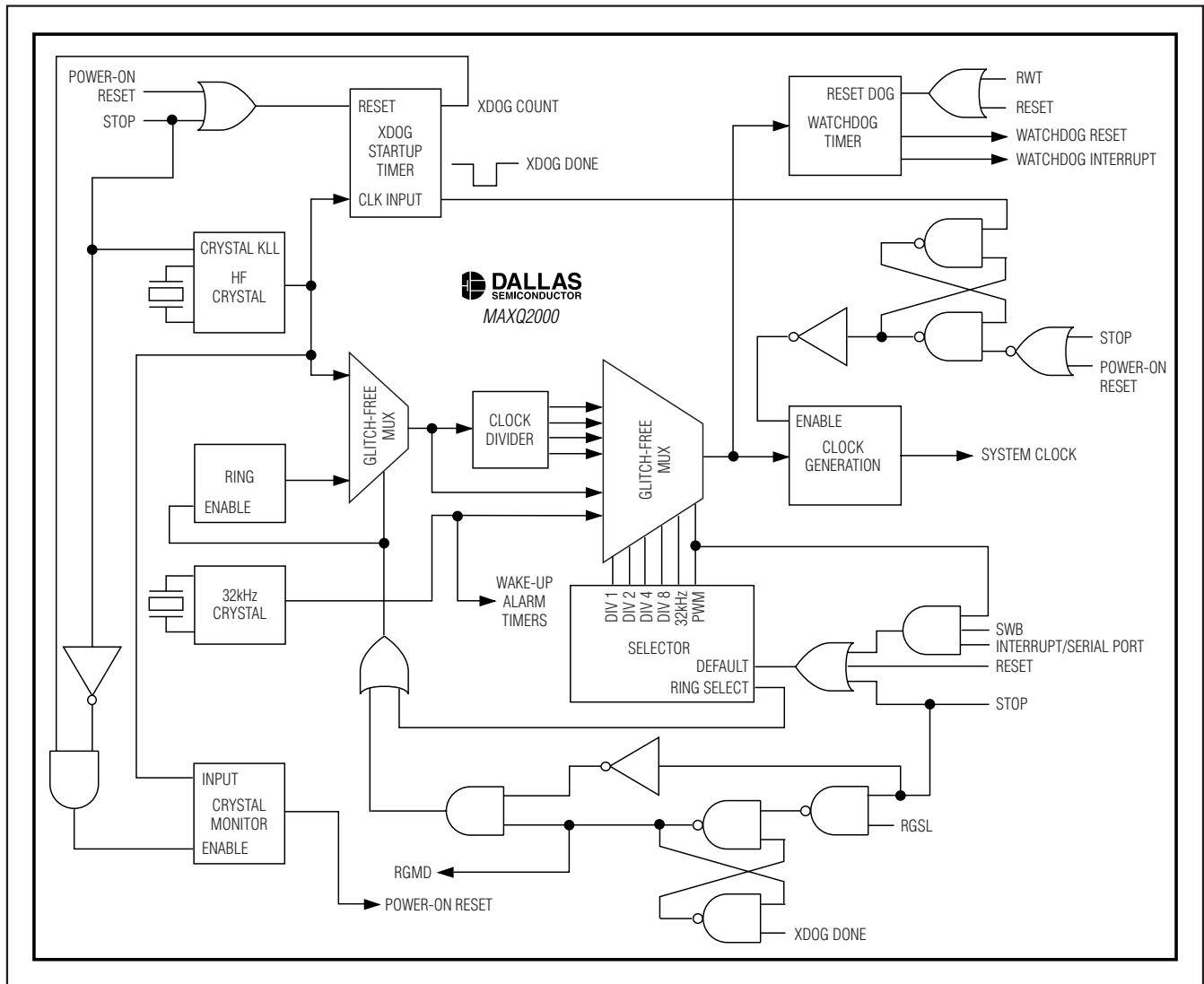


Figure 2. Clock Sources

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Power Management

Advanced power-management features minimize power consumption by dynamically matching the processing speed of the device to the required performance level. This means device operation can be slowed and power consumption minimized during periods of reduced activity. When more processing power is required, the microcontroller can increase its operating frequency. Software-selectable clock-divide operations allow flexibility, selecting whether a system clock cycle is 1, 2, 4, or 8 oscillator cycles. By performing this function in software, a lower power state can be entered without the cost of additional hardware.

For extremely power-sensitive applications, three additional low-power modes are available:

- PMM1: divide-by-256 power-management mode (PMME = 1, CD1:0 = 00b)
- PMM2: 32kHz power-management mode (PMME = 1, CD1:0 = 11b)
- Stop mode (STOP = 1)

In PMM1, one system clock is 256 oscillator cycles, significantly reducing power consumption while the microcontroller functions at reduced speed. In PMM2, the device can run even slower by using the 32kHz oscillator as the clock source. The optional switchback feature allows enabled interrupt sources including external interrupts, UARTs, and the SPI module to quickly exit the power-management modes and return to a faster internal clock rate.

Power consumption reaches its minimum in Stop mode. In this mode, the external oscillator, system clock, and all processing activity is halted. Stop mode is exited when an enabled external interrupt pin is triggered, an external reset signal is applied to the $\overline{\text{RESET}}$ pin, or the RTC time-of-day alarm is activated. Upon exiting Stop mode, the microcontroller can choose to wait for the external high-frequency crystal to complete its warmup period, or it can start execution immediately from its internal ring oscillator while the warmup period completes.

Interrupts

Multiple interrupt sources are available for quick response to internal and external events. The MAXQ architecture uses a single interrupt vector (IV), single interrupt-service routine (ISR) design. For maximum flexibility, interrupts can be enabled globally, individually, or by module. When an interrupt condition occurs, its individual flag is set, even if the interrupt source is disabled at the local, module, or global level. Interrupt flags must be cleared within the user-interrupt routine

to avoid repeated interrupts from the same source. Application software must ensure a delay between the write to the flag and the RETI instruction to allow time for the interrupt hardware to remove the internal interrupt condition. Asynchronous interrupt flags require a one-instruction delay and synchronous interrupt flags require a two-instruction delay.

When an enabled interrupt is detected, software jumps to a user-programmable interrupt vector location. The IV register defaults to 0000h on reset or power-up, so if it is not changed to a different address, the user program must determine whether a jump to 0000h came from a reset or interrupt source.

Once software control has been transferred to the ISR, the interrupt identification register (IIR) can be used to determine if a system register or peripheral register was the source of the interrupt. The specified module can then be interrogated for the specific interrupt source and software can take appropriate action. Because the interrupts are evaluated by user software, the user can define a unique interrupt priority scheme for each application. The following interrupt sources are available. Sources marked with an asterisk are not available on the 56-pin version.

- Watchdog Interrupt
- External Interrupts 0 to 15 (INT10*, INT11*)
- RTC Time-of-Day and Subsecond Alarms
- Serial Port 0 Receive and Transmit Interrupts
- Serial Port 1 Receive and Transmit Interrupts*
- SPI Mode Fault, Write Collision, Receive Overrun, and Transfer Complete Interrupts
- Timer 0 Low Compare, Low Overflow, Capture/Compare, and Overflow Interrupts
- Timer 1 Low Compare, Low Overflow, Capture/Compare, and Overflow Interrupts
- Timer 2 Low Compare, Low Overflow, Capture/Compare, and Overflow Interrupts
- 1-Wire Presence Detect, Transmit Buffer Empty, Transmit Shift Register Empty, Receive Buffer Full, and Shift Register Full, Short, and Low Interrupts*

Reset Sources

Several reset sources are provided for microcontroller control. Although code execution is halted in the reset state, the high-frequency oscillator and the ring oscillator continue to oscillate. Internal resets such as the power-on and watchdog resets assert the $\overline{\text{RESET}}$ pin low.

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High-Speed Hardware Multiplier

The hardware multiplier module performs high-speed multiply, square, and accumulate operations, and can complete a 16-bit x 16-bit multiply-and-accumulate operation in a single cycle. The hardware multiplier consists of two 16-bit parallel-load operand registers (MA, MB), an accumulator that is formed by up to three 16-bit parallel registers (MC2, MC1, and MC0), and a status/control register (MCNT). Loading the registers can automatically initiate the operation, saving time on repetitive calculations. The accumulate function of the hardware multiplier is an essential element of digital filtering, signal processing, and PID control systems.

The hardware multiplier module supports the following operations:

- Multiply unsigned (16 bit x 16 bit)
- Multiply signed (16 bit x 16 bit)
- Multiply-Accumulate unsigned (16 bit x 16 bit)
- Multiply-Accumulate signed (16 bit x 16 bit)
- Square unsigned (16 bit)
- Square signed (16 bit)
- Square-Accumulate unsigned (16 bit)
- Square-Accumulate signed (16 bit)

Real-Time Clock

A binary real-time clock keeps the time of day in absolute seconds with 1/256-second resolution. The 32-bit second counter can count up to approximately 136 years and be translated to calendar format by the application software. A time-of-day alarm and independent subsecond alarm can cause an interrupt, or wake the device from Stop mode.

The independent subsecond alarm runs from the same RTC, and allows the application to perform periodic interrupts up to ones with a granularity of approximately 3.9ms. This creates an additional timer that can be used to measure long periods without performance degradations. Traditionally, long time periods have been measured using multiple interrupts from shorter programmable timers. Each timer interrupt required servicing, with each accompanying interruption slowing system operation. By using the RTC subsecond timer as a long-period timer, only one interrupt is needed, eliminating the performance hit associated with using a shorter timer.

An internal crystal oscillator clocks the RTC using integrated 6pF load capacitors, and give the best performance when mated with a 32.768kHz crystal rated for a 6pF load. No external load capacitors are required. Higher accuracy can be obtained by supplying an external clock source to the RTC. The frequency accuracy of a crystal-based oscillator circuit is dependent upon crystal accuracy, the match between the crystal and the oscillator capacitor load, ambient temperature, etc. An error of 20ppm is equivalent to approximately 1 minute per month.

Programmable Timers

The microcontroller incorporates three 16-bit programmable instances of the Timer 2 peripheral, denoted TR2A, TR2B, and TR2C. These timers can be used in counter/timer/capture/compare/PWM functions, allowing precise control of internal and external events. Timer 2 supports optional single-shot, external gating, and polarity control options.

Timer 2

The Timer 2 peripheral includes the following:

- 16-bit autoreload timer/counter
- 16-bit capture
- 16-bit counter
- 8-bit capture and 8-bit timer
- 8-bit counter and 8-bit timer

Watchdog Timer

An internal watchdog timer greatly increases system reliability. The timer resets the device if software execution is disturbed. The watchdog timer is a free-running counter designed to be periodically reset by the application software. If software is operating correctly, the counter will be periodically reset and never reach its maximum count. However, if software operation is interrupted, the timer does not reset, triggering a system reset and optionally a watchdog timer interrupt. This protects the system against electrical noise or electrostatic discharge (ESD) upsets that could cause uncontrolled processor operation. The internal watchdog timer is an upgrade to older designs with external watchdog devices, reducing system cost and simultaneously increasing reliability.

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The watchdog timer is controlled through bits in the WDCN register. Its timeout period can be set to one of four programmable intervals ranging from 2^{12} to 2^{21} system clocks in its default mode, allowing flexibility to support different types of applications. The interrupt occurs 512 system clocks before the reset, allowing the system to execute an interrupt and place the system in a known, safe state before the device performs a total system reset. At 16MHz, watchdog timeout periods can be programmed from 256 μ s to 33.5s, depending on the system clock mode.

Serial Peripherals

The microcontroller incorporates several common serial-peripheral interfaces for interconnection with popular external devices. Multiple formats provide maximum flexibility and lower cost when designing a system.

UARTs

Serial interfacing is provided through one (-RBX/-RBX+) or two (-RAX/-RAX+/-RFX/-RFX+) 8051-style universal synchronous/asynchronous receiver/transmitters. The UART allows the device to conveniently communicate with other RS-232 interface-enabled devices, as well as PCs and serial modems when paired with an external RS-232 line driver/receiver. The dual independent UARTs can communicate simultaneously at different baud rates with two separate peripherals. The UART can detect framing errors and indicate the condition through a user-accessible software bit.

The time base of the serial ports is derived from either a division of the system clock or the dedicated baud clock generator. The following table summarizes the operating characteristics as well as the maximum baud rate of each mode:

| MODE | TYPE | START BITS | DATA BITS | STOP BIT | MAX BAUD RATE AT 16MHz |
|--------|--------------|------------|-----------|----------|------------------------|
| Mode 0 | Synchronous | N/A | 8 | N/A | 4Mbps |
| Mode 1 | Asynchronous | 1 | 8 | 1 | 500kbps |
| Mode 2 | Asynchronous | 1 | 8 + 1 | 1 | 500kbps |
| Mode 3 | Asynchronous | 1 | 8 + 1 | 1 | 500kbps |

1-Wire Bus Master

The MAXQ2000-RAX/-RAX+/-RFX/-RFX+ include a Dallas Semiconductor 1-Wire bus master, which communicates to other 1-Wire peripherals, including *iButton*® products, through a simple bidirectional signaling scheme over a single electrical connection. The bus master provides complete control of the 1-Wire bus and transmit and receive activities, and generates all timing and control sequences of the 1-Wire bus. Communication between the CPU and the bus master is achieved through read/write access of the 1-Wire master address (OWA) and 1-Wire master data (OWD) peripheral registers. Detailed operation of the 1-Wire bus is described in the *Book of iButton Standards* (www.maxim-ic.com/iButtonbook).

Serial-Peripheral Interface (SPI) Module

The SPI port is a common, high-speed, synchronous peripheral interface that shifts a bit stream of variable length and data rate between the microcontroller and other peripheral devices. The SPI can be used to communicate with other microcontrollers, serial shift registers, or display drivers. Multiple master and slave modes permit communication with multiple devices in the same system. Programmable clock frequency, character lengths, polarity, and error handling enhance the usefulness of the peripheral. The maximum baud rate of the SPI interface is 1/2 the system clock for master mode operation and 1/8 the system clock for slave mode operation.

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In-Circuit Debug

Embedded debugging capability is available through the JTAG-compatible Test Access Port. Embedded debug hardware and embedded ROM firmware provide in-circuit debugging capability to the user application, eliminating the need for an expensive in-circuit emulator. Figure 4 shows a block diagram of the in-circuit debugger. The in-circuit debug features include:

- a hardware debug engine,
- a set of registers able to set breakpoints on register, code, or data accesses, and
- a set of debug service routines stored in the utility ROM.

The embedded hardware debug engine is an independent hardware block in the microcontroller. The debug engine can monitor internal activities and interact with selected internal registers while the CPU is executing user code. Collectively, the hardware and software features allow two basic modes of in-circuit debugging:

- Background mode allows the host to configure and set up the in-circuit debugger while the CPU continues to execute the application software at full speed. Debug mode can be invoked from background mode.
- Debug mode allows the debug engine to take control of the CPU, providing read/write access to internal registers and memory, and single-step trace operation.

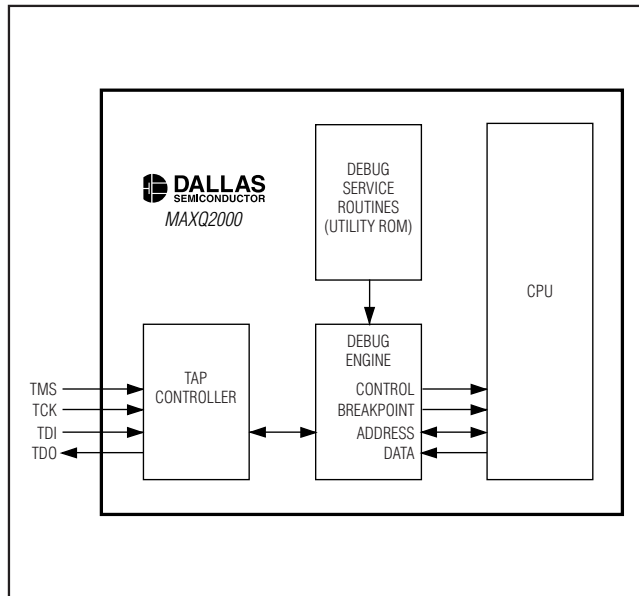


Figure 4. In-Circuit Debugger

LCD Controller

The MAXQ2000 microcontroller incorporates an LCD controller that interfaces to common low-voltage displays. By incorporating the LCD controller into the microcontroller, the design requires only an LCD glass rather than a considerably more expensive LCD module. Every character in an LCD glass is composed of one or more segments, each of which is activated by selecting the appropriate segment and common signal. The microcontroller can multiplex combinations of up to 33 segment (SEG0–SEG32) outputs and four common signal outputs (COM0–COM3). Unused segment outputs can be used as general-purpose port pins.

The segments are easily addressed by writing to dedicated display memory. Once the LCD controller settings and display memory have been initialized, the 17-byte display memory is periodically scanned, and the segment and common signals are generated automatically at the selected display frequency. No additional processor overhead is required while the LCD controller is running. Unused display memory can be used for general-purpose storage.

The design is further simplified and cost-reduced by the inclusion of software-adjustable internal voltage dividers to control display contrast, using either VDDIO or an external voltage. If desired, contrast can also be controlled with an external resistance. The features of the LCD controller include the following:

- Automatic LCD segment and common-drive signal generation
- Four display modes supported:
 - Static (COM0)
 - 1/2 duty multiplexed with 1/2 bias voltages (COM0, COM1)
 - 1/3 duty multiplexed with 1/3 bias voltages (COM0, COM1, COM2)
 - 1/4 duty multiplexed with 1/3 bias voltages (COM0, COM1, COM2, COM3)
- Up to 36 segment outputs and four common-signal outputs
- 17 bytes (136 bits) of display memory
- Flexible LCD clock source, selectable from 32kHz or HFC1k / 128
- Adjustable frame frequency
- Internal voltage-divider resistors eliminate requirement for external components
- Internal adjustable resistor allows contrast adjustment without external components

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- Flexibility to use external resistors to adjust drive voltages and current capacity

A simple LCD-segmented glass interface example demonstrates the minimal hardware required to interface to a MAXQ2000 microcontroller. A two-character LCD is controlled, with each character containing seven segments plus decimal point. The LCD controller is configured for 1/2 duty cycle operation, meaning the active segment is controlled using a combination of segment signals, and COM0 or COM1 signals are used to select the active display.

Applications

The low-power, high-performance RISC architecture of the MAXQ2000 makes it an excellent fit for many portable or battery-powered applications that require cost-effective computing. The high-throughput core is complemented by a 16-bit hardware multiplier-accumulator, allowing the implementation of sophisticated computational algorithms. Applications benefit from a wide range of peripheral interfaces, allowing the microcontroller to communicate with many external devices. With integrated LCD support of up to 100 or 132 segments, applications can support complex user interfaces. Displays are driven directly with no additional external hardware required. Contrast can be adjusted using a built-in, adjustable resistor. The simplified architecture

reduces component count and board space, critical factors in the design of portable systems.

The MAXQ2000 is ideally suited for applications such as medical instrumentation, portable blood glucose equipment, and data collection devices. For blood glucose measurement, the microcontroller integrates an SPI interface that directly connects with analog front ends for measuring test strips.

Additional Documentation

Designers must have four documents to fully use all the features of this device. This data sheet contains pin descriptions, feature overviews, and electrical specifications. Errata sheets contain deviations from published specifications. The user's guides offer detailed information about device features and operation. The following documents can be downloaded from www.maxim-ic.com/microcontrollers.

- The MAXQ2000 errata sheet, available at www.maxim-ic.com/errata.
- The *MAXQ Family User's Guide*, which contains detailed information on core features and operation, including programming.
- The *MAXQ Family User's Guide: MAXQ2000 Supplement*, which contains detailed information on features specific to the MAXQ2000.

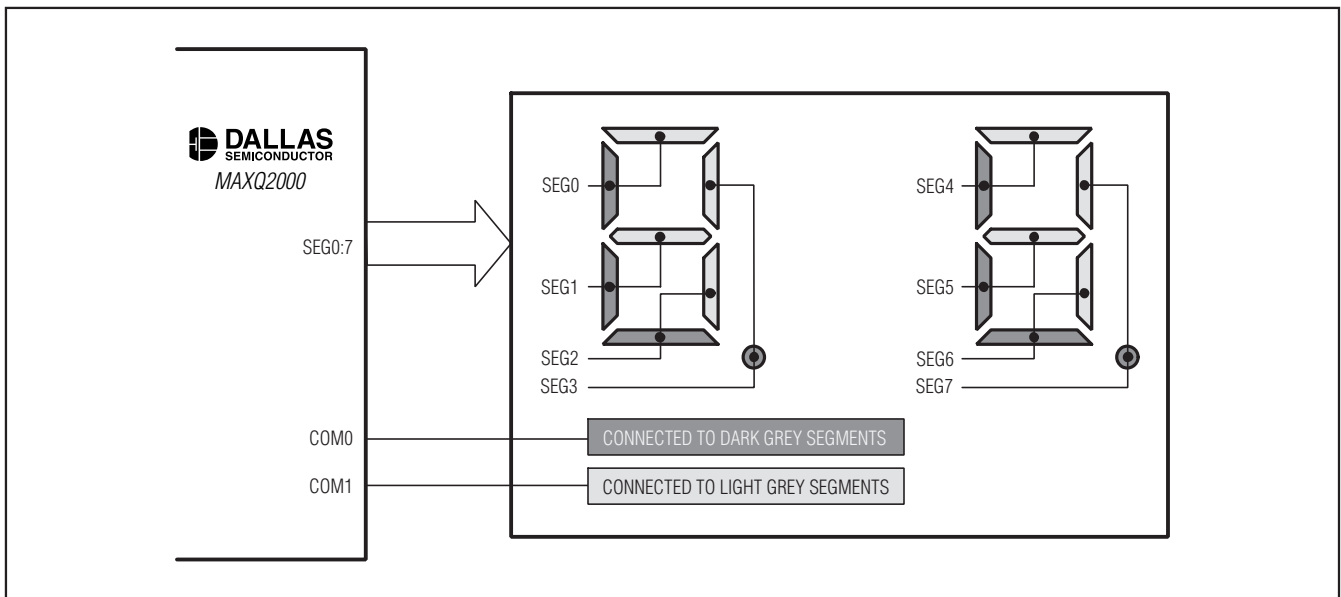


Figure 5. Two-Character, 1/2 Duty, LCD Interface Example

Low-Power LCD Microcontroller

Development and Technical Support

A variety of highly versatile, affordably priced development tools for this microcontroller are available from Maxim and third-party suppliers, including:

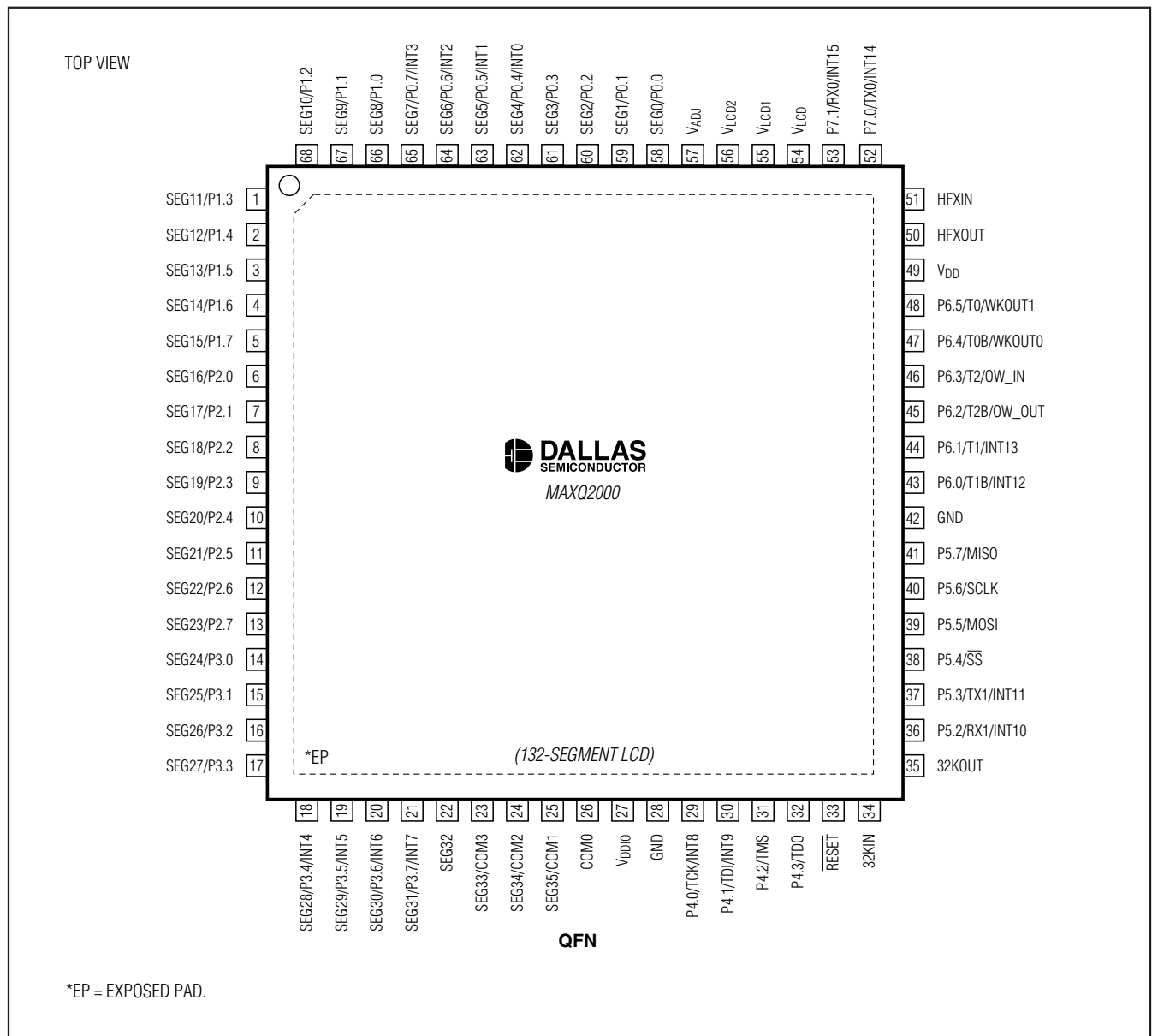
- Compilers
- In-circuit emulators

- Integrated development environments (IDEs)
- JTAG-to-serial converters for programming and debugging

A partial list of development tool vendors can be found on our website at www.maxim-ic.com/MAXQ_tools.

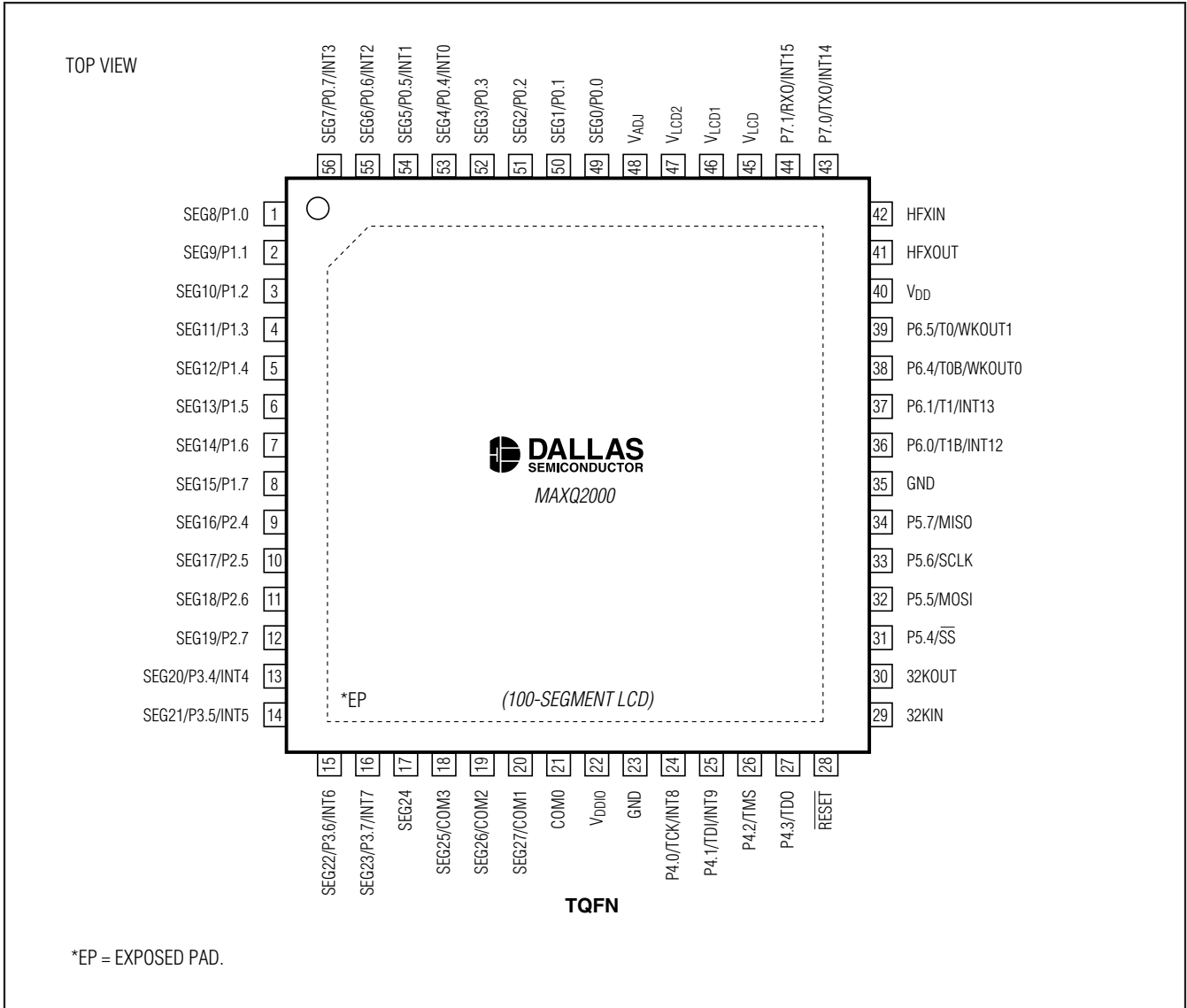
For technical support, go to www.maxim-ic.com/support.

Pin Configurations



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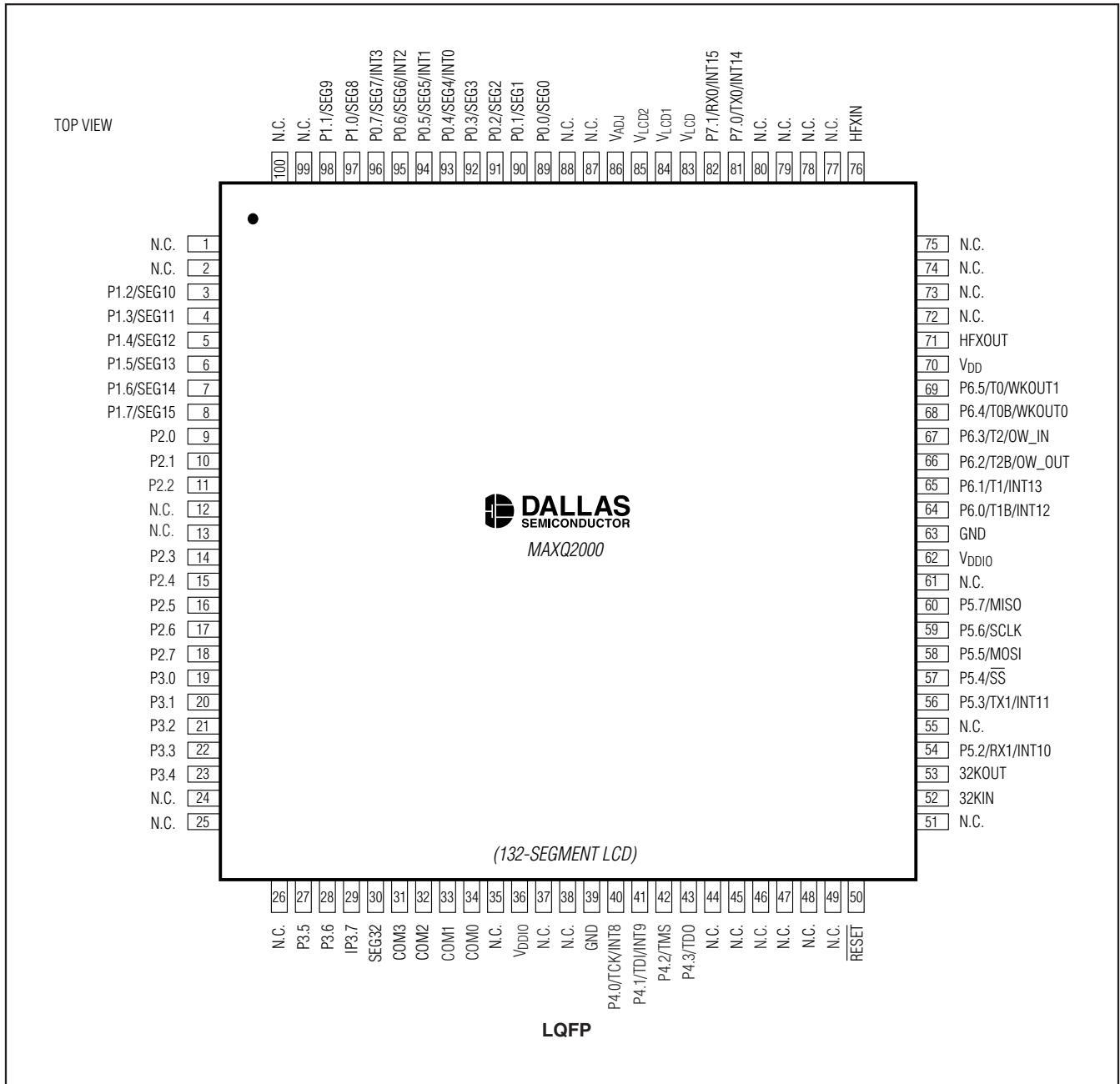
Pin Configurations (continued)



Low-Power LCD Microcontroller

Pin Configurations (continued)

MAXQ2000



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MAXQ2000

Ordering Information

| PART | PROGRAM MEMORY | DATA MEMORY | LCD SEGMENTS | EXTERNAL INTERRUPTS | UARTS | PIN-PACKAGE | PKG CODE |
|---------------|----------------|-------------|--------------|---------------------|-------|-------------|----------|
| MAXQ2000-RAX | 32kWord Flash | 1kWord SRAM | 132 | 16 | 2 | 68 QFN | G6800-4 |
| MAXQ2000-RAX+ | 32kWord Flash | 1kWord SRAM | 132 | 16 | 2 | 68 QFN | G6800+4 |
| MAXQ2000-RBX | 32kWord Flash | 1kWord SRAM | 100 | 14 | 1 | 56 TQFN | T5688+2 |
| MAXQ2000-RBX+ | 32kWord Flash | 1kWord SRAM | 100 | 14 | 1 | 56 TQFN | T5688-2 |
| MAXQ2000-RFX | 32kWord Flash | 1kWord SRAM | 132 | 16 | 2 | 100 LQFP | — |
| MAXQ2000-RFX+ | 32kWord Flash | 1kWord SRAM | 132 | 16 | 2 | 100 LQFP | — |

Note: All devices are specified over the -40°C to +85°C operating temperature range.
 +Denotes a Pb-free/RoHS-compliant package.

Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.

| PACKAGE TYPE | PACKAGE CODE | DOCUMENT NO. |
|--------------|--------------|-------------------------|
| 68 QFN | G6800-4 | 21-0122 |
| 56 TQFN | T5688-2 | 21-0135 |
| 100 LQFP | — | 21-0297 |

Low-Power LCD Microcontroller

Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
|-----------------|---------------|--|---------------------|
| 0 | 10/04 | Initial release for QFN package variant. | — |
| 1 | 10/04 | New product release for TQFN package variant. | 1 |
| 2 | 12/04 | In the <i>Features</i> section under <i>Peripheral Features</i> , corrected accumulator to show 48 bits (not 40 bits). | 1 |
| | | In the <i>Electrical Characteristics</i> table, added Active Current line for 2.2V, 20MHz flash operation; $V_{IH2(MIN)}$ changed from $0.8 \times V_{DDIO}$ to $0.75 \times V_{DDIO}$; updated V_{IH} , V_{IL} , V_{OH} , and V_{OL} data to match GBD/FTEC data. | 2, 3 |
| | | Replaced the package drawing for 56-pin package. | 38 |
| 3 | 6/05 | Added lead-free part numbers to the <i>Ordering Information</i> table. | 1 |
| | | In the <i>Electrical Characteristics</i> table under LCD Segment Voltage, clarified wording on V_{ADJ} spec to $V_{ADJ(MIN)} = V_{ADJ}$ and $V_{ADJ(MAX)} = 0.1V$; changed ISEGxx to 3 μ A. | 3 |
| 4 | 10/05 | Clarified that flash memory write/erase cycles and data retention specifications are at +25°C. | 4 |
| 5 | 1/06 | Clarified V_{IH1}/V_{IH3} specifications, matching presented values to test program values ($0.8 \times V_{DDIO}$); clarified V_{IH2} specification, matching presented values to test program values ($0.8 \times V_{LCD}$); clarified V_{IL2} specification, matching presented values to test program values ($0.2 \times V_{DDIO}$). These changes do not affect the testing or operation of the device. | 2, 3 |
| | | Corrected typo on pin 38 (<i>Pin Configuration</i>) from P4/ \overline{SS} to P5.4/ \overline{SS} . | 33 |
| 6 | 3/06 | Corrected Pb-free package number denotations. Should be MAXQ2000-RAX+ and MAXQ2000-RBX+. | 1, 30, 34 |
| 7 | 6/06 | Added Revision A3 typ and max conditions to I_{DD6} in the <i>Electrical Characteristics</i> table. | 2 |
| 8 | 12/06 | Added 100-pin LQFP package. | 1, 7–11, 30, 35, 42 |
| | | Added EP lines and note to QFN and TQFN pin configurations. | 33, 34 |
| | | Changed 4kWords Utility ROM (<i>Memory Organization</i> section) to 4kB. | 13 |
| | | Changed 4k x 16 Utility ROM (Figure 1) to 2k x 16 Utility ROM, changed 8FFFh to 87FFh. | 14 |
| | | Changed 4kWord to 4kB (<i>Utility ROM</i> section). | 15 |
| 9 | 3/08 | Added V_{DD} slew rate specification to <i>Electrical Characteristics</i> table. | 2 |
| | | Corrected references of \overline{SSEL} to \overline{SS} . | 5, 6 |
| | | In the <i>Typical Operating Circuit</i> , added the reset monitor to ensure the V_{DD} slew rate specification is met. | 36 |
| | | Added QFN and TQFN package codes to the <i>Ordering Information</i> table; removed package drawings and replaced with <i>Package Information</i> table. | 37 |

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Revision History (continued)

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
|-----------------|---------------|---|---------------|
| 10 | 7/08 | In the <i>Electrical Characteristics</i> table, changed the conditions for RLADJ from LRA4:LRA0 = 0 to LRA4:LRA0 = 11111b; added the tSSE parameter to the <i>SPI Timing</i> section. | 3, 5 |
| | | Adjusted the location of “tMOV” in the <i>SPI Master Timing</i> figure. | 6 |

MAXQ2000

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